

# Intel® Server System R2000SC Product Family

# Technical Product Specification

Intel order number G71741-001



**Revision 1.0** 

September 2012

**Enterprise Platforms and Services Division** 

# Revision History

Date	Revision Number	Modifications
September 2012	1.0	Initial release.

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Revision 1.0 ix

#### 1. Introduction

This *Technical Product Specification (TPS)* provides system level information for the Intel<sup>®</sup> Server System R2000SC product family. It describes the functions and features of the integrated server system which includes the chassis layout, system boards, power sub-system, cooling sub-system, storage sub-system options, and available installable options. Server board specific detail can be obtained by referencing the *Intel<sup>®</sup> Server Board S2400SC Technical Product Specification*.

In addition, design-level information related to specific server board components/subsystems can be obtained by ordering *External Product Specifications (EPS)* or *External Design Specifications (EDS)* related to this server generation. EPS and EDS documents are made available under NDA with Intel® and must be ordered through your local Intel® representative. See the <u>Reference Documents</u> section at the end of this document for a complete list of available documents.

#### 1.1 Chapter Outline

This document is divided into the following chapters:

- Chapter 1 Introduction
- Chapter 2 Product Family Overview
- Chapter 3 Power Subsystem
- Chapter 4 Thermal Management
- Chapter 5 System Storage and Peripherals Drive Bays Overview
- Chapter 6 Storage Controller Options Overview
- Chapter 7 Front Control Panel and I/O Panel Overview
- Chapter 8 Intel<sup>®</sup> Local Control Panel
- Appendix A Integration and Usage Tips
- Appendix B POST Code Diagnostic LED Decoder
- Appendix C Post Code Errors
- Glossarv
- Reference Documents

#### 1.2 Server Board Use Disclaimer

Intel Corporation server boards support add-in peripherals and contain a number of high-density VLSI and power delivery components that need adequate airflow to cool. Intel® ensures through its own chassis development and testing that when Intel® server building blocks are used together, the fully integrated system will meet the intended thermal requirements of these components. It is the responsibility of the system integrator who chooses not to use Intel®-developed server building blocks to consult vendor datasheets and operating parameters to determine the amount of airflow required for their specific application and environmental conditions. Intel Corporation cannot be held responsible if components fail or the server board does not operate correctly when used outside any of their published operating or non-operating limits.

# 2. Product Family Overview

This generation of Intel 2U server platforms offers a variety of system options to meet the varied configuration requirements of high-density high-performance computing environments. The Intel® Server System R2000SC product family is comprised of several available 2U rack mount server systems that are all integrated with an Intel® Server Board S2400SC.

This chapter provides a high-level overview of the system features and available options as supported in different platform SKUs within this server family. Greater detail for each major system component or feature is provided in the following chapters.

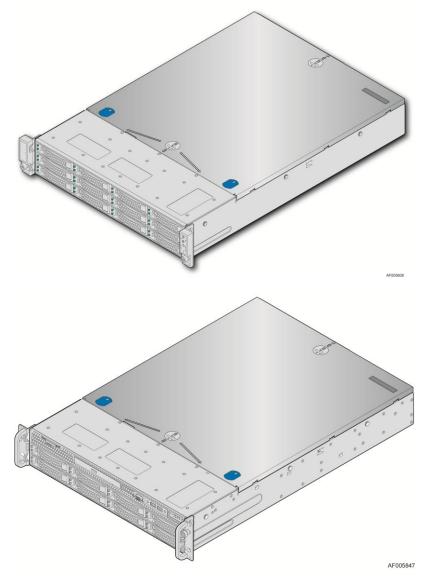


Figure 1. Intel<sup>®</sup> Server System R2000SC

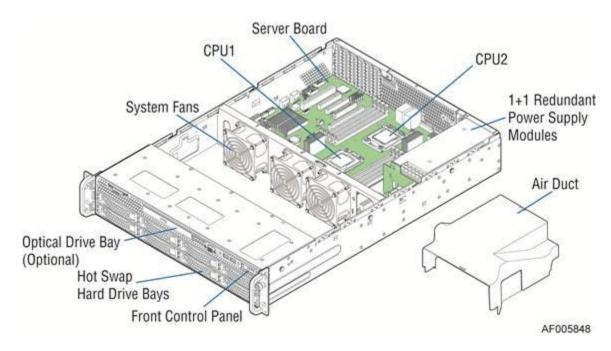


Figure 2. Intel<sup>®</sup> Server System R2000SC without Top Cover

**Table 1. System Feature Set** 

Server System	Integrated Server Board
Intel® Server System R2000SC product family	Intel <sup>®</sup> Server Board S2400SC

Feature	Description	
	Support for one or two Intel® Xeon® processor E5-2400 processor(s) in an FC-LGA 1356 Socket B2 package with Thermal Design Power up to 95W.	
Processor Support	6.4 GT/s, 7.2 GT/s and 8.0 GT/s Intel <sup>®</sup> QuickPath Interconnect (Intel <sup>®</sup> QPI).	
	EVRD (Enterprise Voltage Regulator-Down) 12.	
	Six memory channels, eight memory DIMMs (three channels per processor socket; 2:1:1 layout).	
	Support for 1066/1333 MT/s Unbuffered (UDIMM) LVDDR3 or DDR3 memory.	
	Support for 800/1066/1333/1600 MT/s ECC Registered (RDIMM) DDR3 memory.	
Memory	Support for 800/1066/1333 ECC Registered (RDIMM) LVDDR3 memory.	
	No support for mixing of RDIMMs and UDIMMs.	
	No support for LRDIMMs.	
	No support for Quad Rank DIMMs.	
Chipset	Intel® C602 (-A) chipset with support for storage option upgrade keys.	
	DB9 serial port A connection.	
External I/O	<ul> <li>Two RJ-45 NIC connectors for 10/100/1000 Mb connections: Dual GbE through the Intel<sup>®</sup> 82574L Network Connection.</li> </ul>	
connections	Four USB 2.0 ports at the back of the board.	
	One DB-15 video connector.	

One 2x5 pin USB header, providing front panel support for two USB ports.   One DH10 serial port B header.   One internal Type-A USB 2.0 port.   One 1x7 pin header for optional Intel® Local Control Panel support.   One 1x7 pin header for optional Intel® Local Control Panel support.   One Styl-compliant 24-pin front control panel header.	Feature	Description
Internal I/O connectors/headers  One 9pin USB header for eUSB SSD.  One 1x7 pin header for optional Intel® Local Control Panel support.  One SSI-compilant 24-pin front control panel header.  System Fans  Three 80x80x38mm fixed system fans.  Support for low profile (half-length and half-height) cards only:  Slot 6: PCI Express* Gen3 x16 electrical with x16 physical connector, from first processor.  Slot 5: PCI Express* Gen3 x8 electrical with x8 open ended physical connector, from second processor, blue connector.  Slot 4: PCI Express* Gen3 x8 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen3 x8 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen3 x8 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen3 x8 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen2 x4 electrical with x8 physical connector, from PCH.  Note: Slot 3 does not support intel® Integrated RAID module.  Slot 2: 32-bit/33 MHz PCI slot, from PCH.  Integrated 2D video controller.  Video  Integrated 2D video controller.  Dual monitor video mode is supported.  16 MB DDR3 Memory.  Two SATA connectors at 6Gbps and four SATA connectors at 3Gbps.  Up to eight SAS connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Power Supply  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® Remote Management Module 4 Lite solutions (optional).  Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® Poster Management Software.  Support for Intel® Poster Software.  Support for Intel® Dever Node Manager (Need PMBus*-compliant power supply)  Power Supply  Options  Power Supply  Power Supply  Options  Power Supply  A Redundant power supply option – AC 460W Gold.  Redundant power supply option – AC 750W Platinum.  Fixed power supply option – AC 600W Silver.  Value rack mount rall kit – Intel® Produ		One 2x5 pin USB header, providing front panel support for two USB ports.
Connectors/headers  One 9pin USB header for eUSB SSD. One 1x7 pin header for optional Intel® Local Control Panel support. One SSI-compliant 24-pin front control panel header.  Three 80x80x38mm fixed system fans.  Support for low profile (half-length and half-height) cards only: Slot 6: PCI Express* Gen3 x16 electrical with x16 physical connector, from first processor. Slot 5: PCI Express* Gen3 x8 electrical with x8 open ended physical connector, from second processor, blue connector. Slot 4: PCI Express* Gen3 x4 electrical with x8 physical connector, from first processor. Slot 3: PCI Express* Gen3 x4 electrical with x8 physical connector, from PCH. Note: Slot 3: Des not support Intel® Integrated RAID module. Slot 2: 32-bit/33 MHz PCI slot, from PCH. Note: Slot 3: Dual monitor video mode is supported. Integrated 2D video controller.  Video  Integrated 2D video controller.  Video  16: MB DDR3 Memory.  On-board storage controllers and options  Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 - Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller. Support for Intel® Remote Management Module 4 solutions (ptional). Support for Intel® Remote Management Module 4 solutions (optional). Support for Intel® Remote Management Module 4 Sultions (optional). Support for Intel® Tystem Management Software. Support for Intel® Tystem Management Software.  Support for Intel® Tystem Management Module 4 PMBus*-compliant power supply Options  Power Su	Internal I/O	One DH10 serial port B header.
One 1x7 pin header for optional Intel® Local Control Panel support.  One SSI-compliant 24-pin front control panel header.  Three 80x80x38mm fixed system fans.  Support for low profile (half-length and half-height) cards only:  Slot 6: PCI Express* Gen3 x16 electrical with x16 physical connector, from first processor.  Slot 6: PCI Express* Gen3 x8 electrical with x8 open ended physical connector, from second processor, blue connector.  Slot 4: PCI Express* Gen3 x4 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen2 x4 electrical with x8 physical connector, from PCH.  Note: Slot 3 does not support Intel® Integrated RAID module.  Slot 2: 32-bit/33 MHz PCI slot, from PCH.  Integrated 2D video controller.  Uideo  Uideo  Two SATA connectors at 6Gbps and four SATA connectors at 3Gbps.  Up to eight SAS connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Two SATA connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 Lite solutions (ptional).  Support for Intel® Remote Management Module 4 Lite solutions (optional).  Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® System Management Software.  Support for Intel® Type Remote Management Module 4 Lite solutions (optional).  Redundant power supply option – AC 460W Gold.  Redundant power supply option – AC 750W Platinum.  Fixed power supply option – AC 600W Silver.  Value rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Cable Management Arm – Intel® Product Code – AXXPLOUMA (*supported with		One internal Type-A USB 2.0 port.
One SSI-compliant 24-pin front control panel header.  System Fans Three 80x80x38mm fixed system fans.  Support for low profile (half-length and half-height) cards only:     Slot 6: PCI Express* Gen3 x16 electrical with x16 physical connector, from first processor.     Slot 5: PCI Express* Gen3 x8 electrical with x8 open ended physical connector, from second processor, blue connector.     Slot 4: PCI Express* Gen3 x4 electrical with x8 physical connector, from first processor.     Slot 3: PCI Express* Gen3 x4 electrical with x8 physical connector, from PCH.     Note: Slot 3 does not support Intel® Integrated RAID module.     Slot 2: 32-bit/33 MHz PCI slot, from PCH.     Note: Slot 3 does not support Intel® Integrated RAID module.     Integrated 2D video controller.     Dual monitor video mode is supported.     16 MB DDR3 Memory.     Two SATA connectors at 6Gbps and four SATA connectors at 3Gbps.     Up to eight SAS connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.     Support for Intel® Remote Management Module 4 solutions (ptional).     Support for Intel® Remote Management Module 4 Solutions (ptional).     Support for Intel® System Management Software.     Support for Intel® Product Code Manager (Need PMBus*-compliant power supply).  Power Supply Options  Power Supply Option – AC 600W Silver.  Storage Bay Options  PoverExployed Rack Mount Kit Accessory Options  Pover Sack Mount Kit Accessory Options  Supported Rack Mount Fail Kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail Kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail Kit	connectors/headers	One 9pin USB header for eUSB SSD.
System Fans   Three 80x80x38mm fixed system fans.		One 1x7 pin header for optional Intel <sup>®</sup> Local Control Panel support.
Support for low profile (half-length and half-height) cards only:  Slot 6: PCI Express* Gen3 x16 electrical with x16 physical connector, from first processor.  Slot 5: PCI Express* Gen3 x8 electrical with x8 open ended physical connector, from second processor, blue connector.  Slot 4: PCI Express* Gen3 x4 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen3 x4 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen2 x4 electrical with x8 physical connector, from PCH.  Note: Slot 3 does not support Intel® integrated RAID module.  Slot 2: 32-bit/33 MHz PCI slot, from PCH.  Integrated 2D video controller.  Video  Integrated 2D video controller.  Integrat		One SSI-compliant 24-pin front control panel header.
Slot 6: PCI Express* Gen3 x16 electrical with x16 physical connector, from first processor.  Slot 5: PCI Express* Gen3 x8 electrical with x8 open ended physical connector, from second processor, blue connector.  Slot 4: PCI Express* Gen3 x4 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen2 x4 electrical with x8 physical connector, from PCH.  Note: Slot 3 does not support Intel® Integrated RAID module.  Slot 2: 32-bit/33 MHz PCI slot, from PCH.  Integrated 2D video controller.  Dual monitor video mode is supported.  16 MB DDR3 Memory.  Two SATA connectors at 3Gbps and four SATA connectors at 3Gbps.  On-board storage controllers and options  Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 solutions (ptional).  Support for Intel® Remote Management Module 4 Lite solutions (optional).  Support for Intel® System Management Module 4 Lite solutions (optional).  Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® System Management Software.  Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply) Options  Power Supply Options  On-Board Storage Bay Options  Power Supply Options  Power Supply Options  Power Supply Options  On-Board Storage Rack Mount Kit Accessory Options  Power Supply Options  On-Board Storage Rack Mount Kit Accessory Options  On-Board Storage On-Board Rack Mount Kit Accessory Options  On-Board Storage Rack Mount Kit Accessory Options  On-Board Storage Rack Mount Kit Accessory Options  On-Board Storage Rack Mount Kit Accesso	System Fans	Three 80x80x38mm fixed system fans.
Add-in Cards  Slot 5: PCI Express* Gen3 x8 electrical with x8 open ended physical connector, from second processor, blue connector.  Slot 4: PCI Express* Gen3 x4 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen3 x4 electrical with x8 physical connector, from PCH.  Note: Slot 3 does not support Intel® Integrated RAID module.  Slot 2: 32-bit/33 MHz PCI slot, from PCH.  Integrated 2D video controller.  Dual monitor video mode is supported.  16 MB DDR3 Memory.  On-board storage controllers and options  Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 solutions (ptional).  Support for Intel® Remote Management Module 4 solutions (optional).  Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® System Management Software.  Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply)  Power Supply Options  Power Supply Options  Power Supply Options  Value rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Value rack mount rail kit – Intel® Product Code – AXXPRAIL.  Value rack mount rail kit – Intel® Product Code – AXXPRAIL.  Cable Management Arm – Intel® Product Code – AXXPLUAM (*supported with		Support for low profile (half-length and half-height) cards only:
Second processor, blue connector.  Slot 4: PCI Express* Gen3 x4 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen2 x4 electrical with x8 physical connector, from PCH.  Note: Slot 3 does not support Intel® Integrated RAID module.  Slot 2: 32-bit/33 MHz PCI slot, from PCH.  Integrated 2D video controller.  Dual monitor video mode is supported.  16 MB DDR3 Memory.  On-board storage controllers and options  Pup to eight SAS connectors at 6Gbps and four SATA connectors at 3Gbps.  Up to eight SAS connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 solutions (ptional).  Support for Intel® Remote Management Module 4 solutions (optional).  Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® System Management Software.  Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply).  Power Supply Options  Redundant power supply option – AC 750W Platinum.  Fixed power supply option – AC 600W Silver.  Storage Bay Options  Power Say SATA/SAS Hot Swap Hard Drive Bays.  Value rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Cable Management Arm – Intel® Product Code – AXXIU2UCMA (*supported with		
Slot 4: PCL Express' Gen3 x4 electrical with x8 physical connector, from first processor.  Slot 3: PCI Express* Gen2 x4 electrical with x8 physical connector, from PCH.  Note: Slot 3 does not support Intel® Integrated RAID module.  Slot 2: 32-bit/33 MHz PCI slot, from PCH.  Integrated 2D video controller.  Dual monitor video mode is supported.  16 MB DDR3 Memory.  Two SATA connectors at 6Gbps and four SATA connectors at 3Gbps.  controllers and options  Portion of the second options  Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 solutions (ptional).  Server Management  Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® System Management Software.  Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply).  Power Supply Options  Redundant power supply option – AC 460W Gold.  Redundant power supply option – AC 600W Silver.  Storage Bay Options  Power Sata Sata/SAS Hot Swap Hard Drive Bays.  Value rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Cable Management Arm – Intel® Product Code – AXXI12UCMA (*supported with		
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Slot 2: 32-bit/33 MHz PCI slot, from PCH.  Integrated 2D video controller.  Dual monitor video mode is supported.  16 MB DDR3 Memory.  Two SATA connectors at 6Gbps and four SATA connectors at 3Gbps.  Up to eight SAS connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 solutions (ptional).  Support for Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® System Management Software.  Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply).  Power Supply Options  Power Supply Options  Power Supply Options  12x 3.5" SATA/SAS Hot Swap Hard Drive Bays.  Supported Rack Mount Kit Accessory Options  Value rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXPRAIL.  Cable Management Arm – Intel® Product Code – AXXTU2UCMA (*supported with		
Integrated 2D video controller.     Dual monitor video mode is supported.     16 MB DDR3 Memory.  On-board storage controllers and options  Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.     Support for Intel® Remote Management Module 4 solutions (ptional).     Support for Intel® Remote Management Module 4 Lite solutions (optional).     Intel® Light-Guided Diagnostics on field replaceable units.     Support for Intel® System Management Software.     Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply).  Power Supply Options  Power Supply Options  Power Supply Options  Power Supply Options  Supported Rack Mount Kit Accessory Option.  Value rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXPRAIL.  Cable Management Arm – Intel® Product Code – AXXIU2UCMA (*supported with)		<b>Note</b> : Slot 3 does not support Intel <sup>®</sup> Integrated RAID module.
Dual monitor video mode is supported.		Slot 2: 32-bit/33 MHz PCI slot, from PCH.
On-board storage controllers and options  Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  On-board ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 solutions (ptional).  Server Management  Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® System Management Software.  Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply).  Power Supply Options  Pixed power supply option – AC 460W Gold.  Redundant power supply option – AC 750W Platinum.  Fixed power supply option – AC 600W Silver.  Supported Rack Mount Kit Accessory Options  Power Supply Options  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 solutions (ptional).  Support for Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply).  Redundant power supply option – AC 460W Gold.  Redundant power supply option – AC 750W Platinum.  Fixed power supply option – AC 600W Silver.  Storage Bay Options  Value rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXPRAIL.  Cable Management Arm – Intel® Product Code – AXX1U2UCMA (*supported with		Integrated 2D video controller.
On-board storage controllers and options  Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 Solutions (ptional).  Support for Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® System Management Software.  Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply)  Power Supply Options  Potential Support of Support of Support of Supported Rack Mount Kit Accessory Options  Two SATA connectors at 3Gbps and four SATA connectors at 3Gbps.  Up to eight SAS connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Tup to eight SAS connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Tup to eight SAS connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 Solutions (ptional).  Support for Intel® Remote Management Software.  Support for Intel® System Management Software.  Support of Intel® Product Code - AXXELVRAIL.  Tool-less rack mount rail kit - Intel® Product Code - AXXELVRAIL.  Tool-less rack mount rail kit - Intel® Product Code - AXXPRAIL.  Cable Management Arm - Intel® Product Code - AXX1U2UCMA (*supported with)	Video	Dual monitor video mode is supported.
controllers and options  • Up to eight SAS connectors at 3Gbps with optional Intel® C600 RAID Upgrade Keys.  Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  • Onboard ServerEngines* LLC Pilot III* Controller.  • Support for Intel® Remote Management Module 4 solutions (ptional).  • Support for Intel® Remote Management Module 4 Lite solutions (optional).  • Support for Intel® Remote Management Module 4 Lite solutions (optional).  • Intel® Light-Guided Diagnostics on field replaceable units.  • Support for Intel® System Management Software.  • Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply)  • Redundant power supply option – AC 460W Gold.  • Redundant power supply option – AC 750W Platinum.  • Fixed power supply option – AC 600W Silver.  Storage Bay Options  • 12x 3.5" SATA/SAS Hot Swap Hard Drive Bays.  • 8x 3.5" SATA/SAS Hot Swap Hard Drive Bays.  • Value rack mount rail kit – Intel® Product Code – AXXELVRAIL.  • Tool-less rack mount rail kit – Intel® Product Code – AXXPRAIL.  Cable Management Arm – Intel® Product Code – AXXIU2UCMA (*supported with		16 MB DDR3 Memory.
Security  Intel® Trusted Platform Module (TPM) - AXXTPME5 – Accessory Option.  Onboard ServerEngines* LLC Pilot III* Controller.  Support for Intel® Remote Management Module 4 solutions (ptional).  Support for Intel® Remote Management Module 4 Lite solutions (optional).  Intel® Light-Guided Diagnostics on field replaceable units.  Support for Intel® System Management Software.  Support for Intel® Intelligent Power Node Manager (Need PMBus*-compliant power supply).  Power Supply Options  Redundant power supply option – AC 460W Gold.  Redundant power supply option – AC 750W Platinum.  Fixed power supply option – AC 600W Silver.  Storage Bay Options  12x 3.5" SATA/SAS Hot Swap Hard Drive Bays.  8x 3.5" SATA/SAS Hot Swap Hard Drive Bays.  Value rack mount rail kit – Intel® Product Code – AXXELVRAIL.  Tool-less rack mount rail kit – Intel® Product Code – AXXPRAIL.  Cable Management Arm – Intel® Product Code – AXXIU2UCMA (*supported with		· · · · · · · · · · · · · · · · · · ·
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Supported Rack Mount Kit Accessory Options  Tool-less rack mount rail kit – Intel® Product Code – AXXPRAIL.  Cable Management Arm – Intel® Product Code – AXX1U2UCMA (*supported with	Options	8x 3.5" SATA/SAS Hot Swap Hard Drive Bays.
Mount Kit Accessory Options  O	Cupported Deals	
Options • Cable Management Arm – Intel® Product Code – AXX1U2UCMA (*supported with		
		AXXPRAIL only).
2-post fixed mount bracket kit – Intel <sup>®</sup> Product Code – AXX2POSTBRCKT.		2-post fixed mount bracket kit – Intel® Product Code – AXX2POSTBRCKT.

## 2.1 Chassis Dimensions

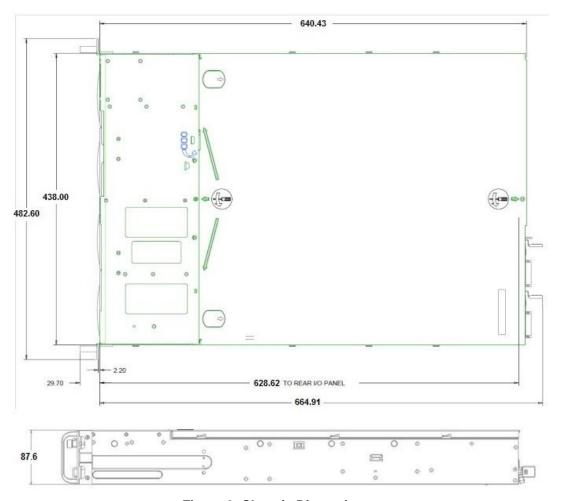


Figure 3. Chassis Dimensions

### 2.2 System Level Environmental Limits

The following table defines the system level operating and non-operating environmental limits.

**Table 2. System Environmental Limits Summary** 

Parameter		Limits
Temperature		
	Operating	ASHRAE Class A2 – Continuous Operation. 10°C to 35°C (50°F to 95°F) with the maximum rate of change not to exceed 10°C per hour
		ASHRAE Class A3 – Includes operation up to 40°C for up to 900 hrs per year.
		ASHRAE Class A4 – Includes operation up to 45°C for up to 90 hrs per year.
	Shipping	-40°C to 70°C (-40°F to 158 F)
Altitude		
	Operating	Support operation up to 3050m with ASHRAE class deratings.
Humidity		

Parameter		Limits
	Shipping	50% to 90%, non-condensing with a maximum wet bulb of 28°C (at temperatures from 25°C to 35°C)
Shock		
	Operating	Half sine, 2g, 11 mSec
	Unpackaged	Trapezoidal, 25g, velocity change is based on packaged weight
	Packaged	Product Weight: ≥ 40 to < 80  Non-palletized Free Fall Height = 18 inches  Palletized (single product) Free Fall Height = NA
Vibration		
	Unpackaged	5 Hz to 500 Hz 2.20 g RMS random
	Packaged	5 Hz to 500 Hz 1.09 g RMS random
AC-DC		
	Voltage	90 Hz to 132 V and 180 V to 264 V
	Frequency	47 Hz to 63 Hz
	Source Interrupt	No loss of data for power line drop-out of 12 mSec
	Surge Non- operating and operating	Unidirectional
	Line to earth Only	AC Leads 2.0 kV I/O Leads 1.0 kV DC Leads 0.5 kV
ESD		
	Air Discharged	12.0 kV
	Contact Discharge	8.0 kV
Acoustics Sound Power Measured		
	Power in Watts	<300 W ≥300 W ≥600 W ≥1000 W
	Servers/Rack Mount BA	7.0 7.0 7.0 7.0

**Disclaimer Note**: Intel® ensures the unpackaged server board and system meet the shock requirement mentioned above through its own chassis development and system configuration. It is the responsibility of the system integrator to determine the proper shock level of the board and system if the system integrator chooses different system configuration or different chassis. Intel Corporation cannot be held responsible, if components fail or the server board does not operate correctly when used outside any of its published operating or non-operating limits.

See the Intel® S2400SC Product Family Power Budget and Thermal Configuration Tool for system configuration requirements and limitations.

## 2.3 System Features and Options Overview

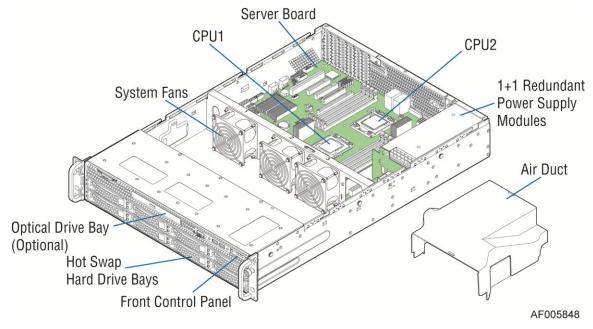


Figure 4. System Components Overview

#### 2.3.1 Hot Swap Hard Drive Bay and Front Panel Options

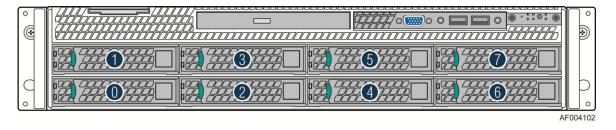


Figure 5. 3.5" Hard Drive Bay - 8 Drive Configuration

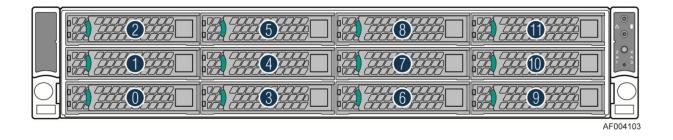


Figure 6. 3.5" Hard Drive Bay - 12 Drive Configuration

#### 2.3.2 Back Panel Features

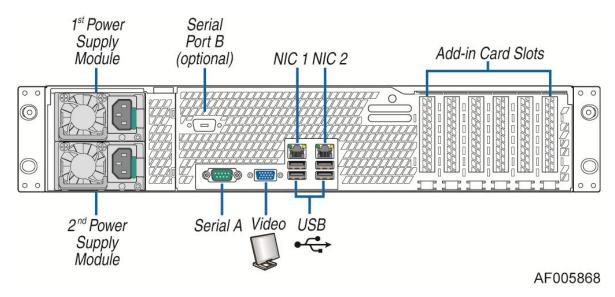
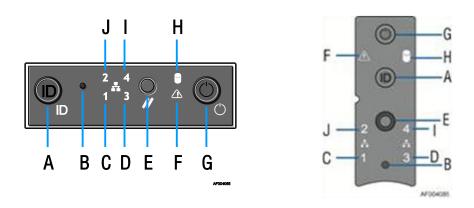


Figure 7. Back Panel Feature Identification

#### 2.3.3 Front Control Panel Options



Label	Description		Description
Α	System ID Button w/Integrated LED		System Status LED
В	NMI Button (recessed, tool required for use)	G	Power Button w/Integrated LED
С	NIC-1 Activity LED	Н	Hard Drive Activity LED
D	NIC-3 Activity LED	I	NIC-4 Activity LED
Е	System Cold Reset Button	J	NIC-2 Activity LED

**Figure 8. Front Control Panel Options** 

#### 2.4 Server Board Features Overview

The following illustration provides a general overview of the server board, identifying key feature and component locations:

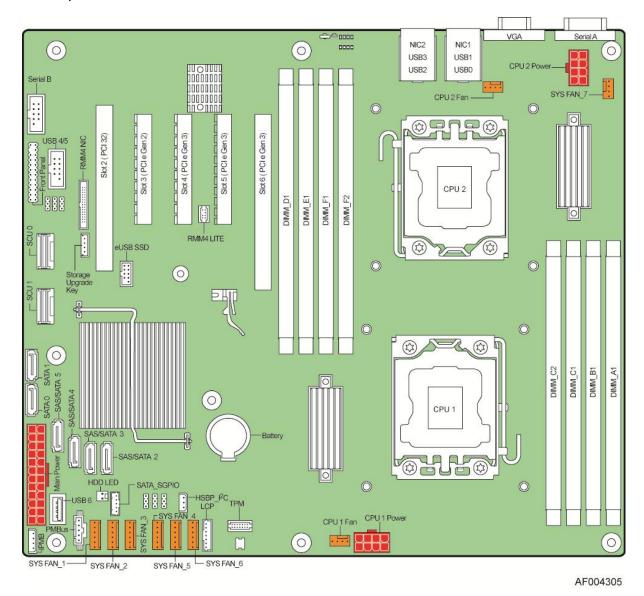


Figure 9. Intel<sup>®</sup> Server Board S2400SC

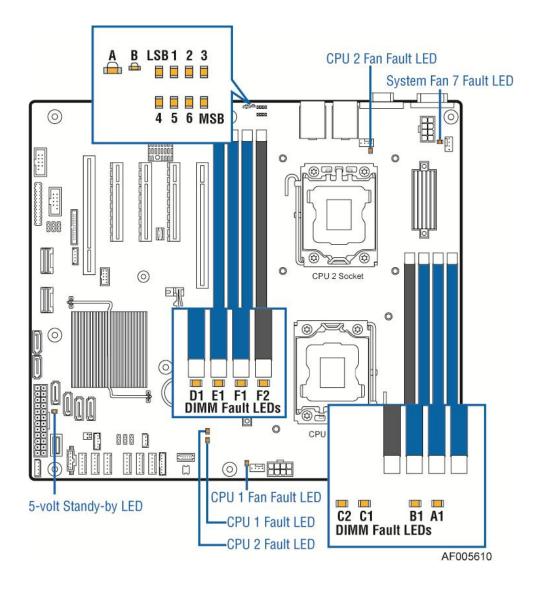


Figure 10. Intel<sup>®</sup> Light-Guided Diagnostic LEDs

## 2.5 Available Front Bezel Support

The optional front bezel is made of molded plastic and uses a snap-on design. When installed, its design allows for maximum airflow to maintain system cooling requirements. The face of the bezel assembly includes optional snap-in identification badge and wave (shown) features to allow for customization.

(Intel® Product Order Code – A2UBEZEL)

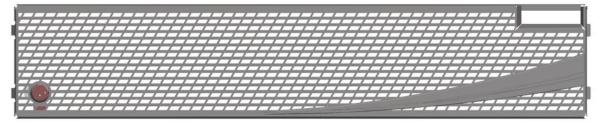


Figure 11. Optional Front Bezel

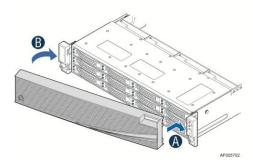


Figure 12. Option Front Bezel with R2000SC System

#### 2.6 Available Rack and Cabinet Mounting Kit Options

- Value rack mount rail kit Intel<sup>®</sup> Product Code AXXELVRAIL
  - o 1U to 4U compatible
  - 110 lbs max support weight
  - o Tool-less chassis attach
  - Tools required to attach to rails to rack
  - 2/3 extension from rack
- Tool-less rack mount rail kit Intel<sup>®</sup> Product Code AXXPRAIL
  - 1U and 2U compatible
  - o 65 lbs max support weight
  - Tool-less installation
  - Full extension from rack
  - Drop in system install
  - Optional cable management arm support
- Cable Management Arm Intel<sup>®</sup> Product Code AXX1U2UCMA (\*supported with AXXPRAIL only)
- 2-Post Fixed mount bracket kit Intel<sup>®</sup> Product Code AXX2POSTBRCKT

**CAUTION**: THE MAXIMUM RECOMMENDED SERVER WEIGHT FOR THE RACK RAILS CAN BE FOUND at <a href="http://www.intel.com/support/motherboards/server/sb/CS-033655.htm">http://www.intel.com/support/motherboards/server/sb/CS-033655.htm</a>. EXCEEDING THE MAXIMUM RECOMMENDED WEIGHT OR MISALIGNMENT OF THE SERVER MAY RESULT IN FAILURE OF THE RACK RAILS HOLDING THE SERVER. Use of a mechanical assist to install and align server into the rack rails is recommended.

# 3. Power Subsystem

This chapter will provide a high level overview of the power management features and specification data for the power supply options available for this server product. Specification variations will be identified for each supported power supply.

The server system can have upto two power supply modules installed, supporting the following power supply configurations: Fixed 600W power supply, 1+0 (single power supply), 1+1 Redundant Power, and 2+0 Combined Power (non-redundant). 1+1 redundant power and 2+0 combined power configurations are automatically configured depending on the total power draw of the system. If the total system power draw exceeds the power capacity of a single power supply module, then power from the second power supply module will be utilized. Should this occur, power redundancy is lost. In a 2+0 power configuration, total power available maybe less then twice the rated power of the installed power supply modules due to the amount of heat produced with both supplies providing peak power. Should system thermals exceed programmed limits, platform management will attempt to keep the system operational. See Closed Loop System Throttling (CLST) later in this chapter and Thermal Management for details.

There are three power supply option available for this server system product: 460W AC redundant, 600W AC Fixed, 750W AC redundant.

The redundant power supplies are modular, allowing for tool-less insertion and extraction from a bay in the back of the chassis. When inserted, the card edge connector of the power supply mates blindly to a matching slot connector on the Power Distribution Board.

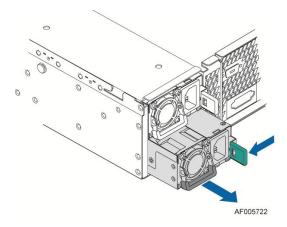


Figure 13. Hot Swap Power Supply for R2000 System

In the event of a power supply failure, redundant 1+1 power supply configurations have support for hot-swap extraction and insertion.

The AC input is auto-ranging and power factor corrected.

#### 3.1 Mechanical Overview

The physical size of the power supply enclosure is 39/40mm x 74mm x 185mm; the power supply contains a single 40mm fan. The power supply has a card edge output that interfaces with a 2x25 card edge connector in the system. The AC plugs directly into the external face of the power supply.

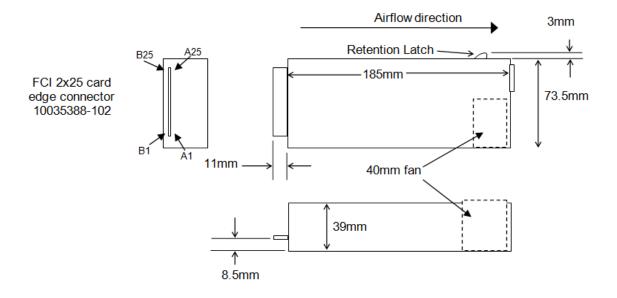


Figure 14. Power Supply Module Mechanical Drawing

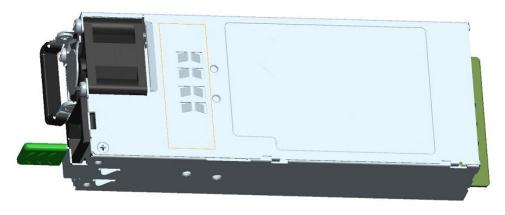


Figure 15. Power Supply Module



Figure 16. Power Supply AC Connector View

#### 3.2 Power Connectors

#### 3.2.1 Power Supply Module Card Edge Connector

Each power supply module has a single 2x25 card edge output connection that plugs directly into a matching connector on the power distribution board. The connector provides both power and communication signals. The following table defines the connector pin-out.

**Table 3. Power Supply Module Output Power Connector Pin-out** 

Pin	Name	Pin	Name
A1	GND	B1	GND
A2	GND	B2	GND
A3	GND	В3	GND
A4	GND	B4	GND
A5	GND	B5	GND
A6	GND	B6	GND
A7	GND	B7	GND
A8	GND	B8	GND
A9	GND	B9	GND
A10	+12V	B10	+12V
A11	+12V	B11	+12V
A12	+12V	B12	+12V
A13	+12V	B13	+12V
A14	+12V	B14	+12V
A15	+12V	B15	+12V
A16	+12V	B16	+12V
A17	+12V	B17	+12V
A18	+12V	B18	+12V
A19	PMBus* SDA	B19	A0 (SMBus* address)
A20	PMBus* SCL	B20	A1 (SMBus* address)
A21	PSON	B21	12V stby
A22	SMBAlert#	B22	Cold Redundancy Bus
A23	Return Sense	B23	12V load share bus
A24	+12V remote Sense	B24	No Connect
A25	PWOK	B25	Compatibility Check pin*

#### 3.2.2 Power Distribution Board Output Wire Harness

The power distribution board has a wire harness output with the following connectors. Listed or recognized component appliance wiring material (AVLV2), CN, rated min 85°C shall be used for all output wiring.

Table 4. Power Distribution Board Output Wire Harness

	Length	To connector		No of	
From	(mm)	#	AWG	pins	Description
Soldered into PDB	550	P1	18	24	Baseboard Power Connector
Soldered into PDB	350	P2	18	8	Processor 0 connector
Soldered into PDB	240	P3	18	8	Processor 1 connector
Soldered into PDB	440	P4	24	5	Signal
Soldered into PDB	550	P5	24	5	SSATA (slim SATA) connector for CD/DVD
Soldered into PDB	200	P6	18	4	Hot swap backplane 1 2x2 Minifit Jr Connector
Soldered into PDB	400	P7	18	4	Hot swap backplane 2 2x2 Minifit Jr Connector
Soldered into PDB	460	P8	18	4	Hot swap backplane 3 2x2 Minifit Jr Connector
P8	100	P9	18	4	1x4 legacy HSBP Power Connector +5V is from the PDB. Others are extended from P8
P9	100	P10	18	4	1x4 legacy HSBP Power Connector
Soldered into PDB	240	P11	18	5	SATA connector for SSD
From P11	240	P12	18	5	SATA connector for SSD

#### 3.2.3 Baseboard Power Connector (P1)

Connector housing: 24-Pin Molex Mini-Fit Jr. 39-01-2245 or equivalent Contact: Molex Mini-Fit, HCS Plus, Female, Crimp 44476 or equivalent

**Table 5. P1 Baseboard Power Connector** 

Pin	Signal	18 AWG Color	Pin	Signal	18 AWG Color
1	+3.3VDC	Orange	13	+3.3VDC	Orange
2	+3.3VDC	Orange	14	-12VDC	Blue
3	СОМ	Black	15	COM	Black
4	+5VDC	Red	16	PSON#	Green (24AWG)
5	СОМ	Black	17	СОМ	Black
6	+5VDC	Red	18	COM	Black
7	СОМ	Black	19	COM	Black
8	PWR OK	Gray (24AWG)	20	Reserved	N.C.
9	5 VSB	Purple	21	+5VDC	Red
10	+12V1	Yellow	22	+5VDC	Red

Pin	Signal	18 AWG Color	Pin	Signal	18 AWG Color
11	+12V1	Yellow	23	+5VDC	Red
12	+3.3VDC	Orange	24	COM	Black

#### 3.2.4 Processor Power Connectors (P2 and P3)

Connector housing: 8-Pin Molex 39-01-2080 or equivalent

Contact: Molex Mini-Fit, HCS Plus, Female, Crimp 44476 or equivalent

**Table 6. Processor Power Connectors** 

Pin	Signal	18 AWG color	Pin	Signal	18 AWG Color
1	СОМ	Black	5*	+12V1	Yellow
2	СОМ	Black	6	+12V1	Yellow
3	СОМ	Black	7	+12V1	Yellow
4	COM	Black	8	+12V1	Yellow

#### 3.2.5 Power Signal Connector (P4)

Connector housing: 5-pin Molex 50-57-9405 or equivalent

Contacts: Molex 16-02-0087 or equivalent

**Table 7. Power Signal Connector** 

Pin	Signal	24 AWG Color
1	I <sup>2</sup> C Clock	White
2	I <sup>2</sup> C Data	Yellow
3	SMBAlert#	Red
4	СОМ	Black
5	3.3RS	Orange

#### 3.2.6 Slim SATA Power Connector (P5)

Connector housing: Amphenol SSATA-111-1201-1-3 or equivalent

Terminal: Copper Alloy. Thickness: 0.25mm

**Table 8. Slim SATA Power Connector** 

Pin	Signal	24 AWG Color
1	NC	
2	+5V	Red
3	+5V	Red
4	NC	
5	GND	Black
6	GND	Black

#### 3.2.7 Hot Swap Backplane Connectors (P6, P7, P8)

Connector housing: MOLEX 0039012045 or equivalent

Contact: Molex: 44476-1111 or equivalent

Table 9. Backplane Power Connectors (P6 and P7)

Pin	Signal	18 AWG color	Pin	Signal	18 AWG Color
1	COM	Black	3	+12V2	Green
2	COM	Black	4	+12V2	Green

**Table 10. Backplane Power Connectors (P8)** 

Pin	Signal	18 AWG color	Pin	Signal	18 AWG Color
1	COM	Black	3	+12V3	Brown
2	COM	Black	4	+12V3	Brown

#### 3.2.8 Expander card power connector (P9, P10)

Connector housing: Amp 1-480424-0 or equivalent

Contact: Amp 61314-1 contact or equivalent

**Table 11. Expander Card Power Connector** 

Pin	Signal	18 AWG Color
1	1 +12V3 Brown	
2	COM	Black
3	COM	Black
4	+5 VDC	Red

#### 3.2.9 SATA 1x5 Peripheral Power Connectors (P11, P12)

Connector housing: Molex 0675-82-0000 or equivalent;

Contact: Molex 0675-81-0000 or equivalent

**Table 12. SATA Peripheral Power Connectors** 

Pin	Signal	18 AWG Color
1	+3.3VDC	Orange
2	COM	Black
3	+5VDC	Red
4	COM	Black
5	+12V1	Yellow

#### 3.3 Power Supply Module Efficiency

The following tables provide the required minimum efficiency level at various loading conditions. These are provided at three different load levels: 100%, 50% and 20%. Efficiency is tested over an AC input voltage range of 115 VAC to 220 VAC.

Table 13. 460 Watt Power Supply Efficiency (Gold)

Loading	100% of maximum	50% of maximum	20% of maximum	10% of maximum
Minimum Efficiency	88%	92%	88%	80%

Table 14. 600 Watt AC Power Supply Efficiency

Loading	100% of maximum	50% of maximum	20% of maximum
Minimum Efficiency	>=85%	>=88%	>=85%

Table 15. 750 Watt Power Supply Efficiency (Platinum)

Loading	100% of maximum	50% of maximum	20% of maximum	10% of maximum
Minimum Efficiency	91%	94%	90%	82%

#### 3.4 Power Cord Specification Requirements

Power cords used must meet the specification requirements listed in the following table:

**Table 16. AC Power Cord Specifications** 

Cable Type	SJT
Wire Size	16 AWG
Temperature Rating	105°C
Amperage Rating	13 A
Voltage Rating	125 V

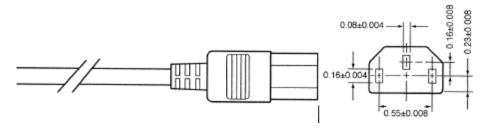


Figure 17. AC Power Cord

#### 3.5 AC Input Requirement

#### 3.5.1 Power Factor

The power supply must meet the power factor requirements stated in the Energy Star® Program Requirements for Computer Servers. These requirements are stated below:

Output power	10% load	20% load	50% load	100% load
Power factor	> 0.65	> 0.80	> 0.90	> 0.95

Tested at 230Vac, 50Hz and 60Hz and 115VAC, 60Hz.

#### 3.5.2 AC Input Voltage Specification

The power supply must operate within all specified limits over the following input voltage range. Harmonic distortion of up to 10% of the rated line voltage must not cause the power supply to go out of specified limits. Application of an input voltage below 85VAC shall not cause damage to the power supply, including a blown fuse.

Parameter	MIN	Rated	VMAX	Start up VAC	Power Off VAC
Voltage (110)	90 Vrms	100-127 Vrms	140 Vrms	85VAC +/- 4VAC	70VAC +/- 5VAC
Voltage (220)	180 Vrms	200-240 Vrms	264 Vrms		
Frequency	47 Hz	50/60	63 Hz		

**Table 17. AC Input Voltage Range** 

#### Notes:

- 1. Maximum input current at low input voltage range shall be measured at 90VAC, at max load.
- 2. Maximum input current at high input voltage range shall be measured at 180VAC, at max load.
- 3. This requirement is not to be used for determining agency input current markings.

#### 3.5.3 AC Line Isolation Requirements

The power supply shall meet all safety agency requirements for dielectric strength. Transformers' isolation between primary and secondary windings must comply with the 3000Vac (4242Vdc) dielectric strength criteria. If the working voltage between primary and secondary dictates a higher dielectric strength test voltage, the highest test voltage should be used. In addition the insulation system must comply with reinforced insulation per safety standard IEC 950. Separation between the primary and secondary circuits, and primary to ground circuits, must comply with the IEC 950 spacing requirements.

#### 3.5.4 AC Line Dropout/Holdup

An AC line dropout is defined to be when the AC input drops to 0VAC at any phase of the AC line for any length of time. During an AC dropout the power supply must meet dynamic voltage regulation requirements. An AC line dropout of any duration shall not cause tripping of control signals or protection circuits. If the AC dropout lasts longer than the holdup time the power supply should recover and meet all turn on requirements. The power supply shall meet the AC dropout requirement over rated AC voltages and frequencies. A dropout of the AC line for any duration shall not cause damage to the power supply.

Loading	Holdup time
70%	12msec

#### 3.5.4.1 AC Line 12VSBHoldup

The 12VSB output voltage should stay in regulation under its full load (static or dynamic) during an AC dropout of **70ms min** (=12VSB holdup time) whether the power supply is in ON or OFF state (PSON asserted or de-asserted).

#### 3.5.5 AC Line Fuse

The power supply shall have one line fused in the **single line fuse** on the line (Hot) wire of the AC input. The line fusing shall be acceptable for all safety agency requirements. The input fuse shall be a slow blow type. AC inrush current shall not cause the AC line fuse to blow under any conditions. All protection circuits in the power supply shall not cause the AC fuse to blow unless a component in the power supply has failed. This includes DC output load short conditions.

#### 3.5.6 AC Inrush

AC line inrush current shall not exceed **55A peak**, for up to one-quarter of the AC cycle, after which, the input current should be no more than the specified maximum input current. The peak inrush current shall be less than the ratings of its critical components (including input fuse, bulk rectifiers, and surge limiting device).

The power supply must meet the inrush requirements for any rated AC voltage, during turn on at any phase of AC voltage, during a single cycle AC dropout condition as well as upon recovery after AC dropout of any duration, and over the specified temperature range (T<sub>op</sub>).

#### 3.5.7 AC Line Transient Specification

AC line transient conditions shall be defined as "sag" and "surge" conditions. "Sag" conditions are also commonly referred to as "brownout"; these conditions will be defined as the AC line voltage dropping below nominal voltage conditions. "Surge" will be defined to refer to conditions when the AC line voltage rises above nominal voltage.

The power supply shall meet the requirements under the following AC line sag and surge conditions:

AC Line Sag (10sec interval between each sagging) Duration Operating AC Voltage Line Performance Criteria Sag Frequency 0 to 1/2 AC Nominal AC Voltage 95% 50/60Hz No loss of function or performance cycle ranges > 1 AC cycle >30% Nominal AC Voltage 50/60Hz Loss of function acceptable, self recoverable ranges

**Table 18. AC Line Sag Transient Performance** 

**Table 19. AC Line Surge Transient Performance** 

AC Line Surge				
Duration	Surge	Operating AC Voltage	Line Frequency	Performance Criteria
Continuous	10%	Nominal AC Voltages	50/60Hz	No loss of function or performance
0 to ½ AC cycle	30%	Mid-point of nominal AC Voltages	50/60Hz	No loss of function or performance

#### 3.5.8 Susceptibility Requirements

The power supply shall meet the following electrical immunity requirements when connected to a cage with an external EMI filter which meets the criteria defined in the SSI document *EPS Power Supply Specification*. For further information on Intel<sup>®</sup> standards, please request a copy of the *Intel*<sup>®</sup> *Environmental Standards Handbook*.

Table 20. Performance Criteria

Level	Description
Α	The apparatus shall continue to operate as intended. No degradation of performance.
В	The apparatus shall continue to operate as intended. No degradation of performance beyond spec limits.
С	Temporary loss of function is allowed provided the function is self-recoverable or can be restored by the operation of the controls.

#### 3.5.9 Electrostatic Discharge Susceptibility

The power supply shall comply with the limits defined in EN 55024: 1998/A1: 2001/A2: 2003 using the *IEC 61000-4-2: Edition 1.2: 2001-04 test standard and performance criteria B* defined in *Annex B of CISPR 24*.

#### 3.5.10 Fast Transient/Burst

The power supply shall comply with the limits defined in EN55024: 1998/A1: 2001/A2: 2003 using the *IEC 61000-4-4*: Second edition: 2004-07 test standard and performance criteria B defined in *Annex B of CISPR 24*.

#### 3.5.11 Radiated Immunity

The power supply shall comply with the limits defined in EN55024: 1998/A1: 2001/A2: 2003 using the *IEC 61000-4-3: Edition 2.1: 2002-09 test standard and performance criteria A* defined in *Annex B of CISPR 24*.

#### 3.5.12 Surge Immunity

The power supply shall be tested with the system for immunity to AC Unidirectional wave; 2kV line to ground and 1kV line to line, per *EN 55024: 1998/A1: 2001/A2: 2003, EN 61000-4-5: Edition 1.1:2001-04.* 

The pass criteria include: No unsafe operation is allowed under any condition; all power supply output voltage levels to stay within proper spec levels; No change in operating state or loss of data during and after the test profile; No component damage under any condition.

The power supply shall comply with the limits defined in EN55024: 1998/A1: 2001/A2: 2003 using the *IEC 61000-4-5: Edition 1.1:2001-04 test standard and performance criteria B* defined in *Annex B of CISPR 24*.

#### 3.5.13 Power Recovery

The power supply shall recover automatically after an AC power failure. AC power failure is defined to be any loss of AC power that exceeds the dropout criteria.

#### 3.5.14 Voltage Interruptions

The power supply shall comply with the limits defined in *EN55024: 1998/A1: 2001/A2: 2003 using the IEC 61000-4-11: Second Edition: 2004-03 test standard and performance criteria C defined in Annex B of CISPR 24.* 

#### 3.5.15 Protection Circuits

Protection circuits inside the power supply cause only the power supply's main outputs to shut down. If the power supply latches off due to a protection circuit tripping, an AC cycle OFF for 15 seconds and a PSON<sup>#</sup> cycle HIGH for one second reset the power supply.

#### 3.5.16 Over-current Protection (OCP)

The power supply shall have current limit to prevent the outputs from exceeding the values shown in table below. If the current limits are exceeded the power supply shall shutdown and latch off. The latch will be cleared by toggling the PSON<sup>#</sup> signal or by an AC power interruption. The power supply shall not be damaged from repeated power cycling in this condition. 12VSB will be auto-recovered after removing OCP limit.

Table 21. 460 Watt Power Supply Over Current Protection

Output Voltage	Input voltage range	Over Current Limits
+12V	90 – 264VAC	47A min; 55A max
12VSB	90 - 264VAC	2A min; 2.5A max

Table 22. 600 Watt Power Supply Over Current Protection

Output Voltage	Continuous Load		
Output Voltage	Current Limit MIN	Current Limit MAX	
+12V1	36A	41A	
+12V2	18.2A	20A	
+12V3	18.2A	20A	
+5V	5.5A	10A	
+3.3V	15.5A	20A	
-12V		4A	
+5VSB		4.5A	

**Table 23. 750 Watt Power Supply Over Current Protection** 

Output Voltage	Input voltage range	Over Current Limits
+12V	90 – 264VAC	72A min; 78A max
12VSB	90 – 264VAC	2.5A min; 3.5A max

#### 3.5.17 Over Voltage Protection (OVP)

The power supply over voltage protection shall be locally sensed. The power supply shall shutdown and latch off after an over voltage condition occurs. This latch shall be cleared by toggling the PSON<sup>#</sup> signal or by an AC power interruption. The values are measured at the output of the power supply's connectors. The voltage shall never exceed the maximum levels when measured at the power connectors of the power supply connector during any single point of fail. The voltage shall never trip any lower than the minimum levels when measured at the power connector. 12VSB will be auto-recovered after removing OVP limit.

Table 24. Over Voltage Protection (OVP) Limits

Output Voltage	MIN (V)	MAX (V)
+12V	13.3	14.5
+12VSB	13.3	14.5

#### 3.5.18 Over-temperature Protection (OTP)

The power supply will be protected against over temperature conditions caused by loss of fan cooling or excessive ambient temperature. In an OTP condition the PSU will shutdown. When the power supply temperature drops to within specified limits, the power supply shall restore power automatically, while the 12VSB remains always on. The OTP circuit must have built in margin such that the power supply will not oscillate on and off due to temperature recovering condition. The OTP trip level shall have a minimum of 4°C of ambient temperature margin.

#### 3.6 Cold Redundancy Support

Power supplies that support cold redundancy can be enabled to go into a low-power state (that is, cold redundant state) in order to provide increased power usage efficiency when system loads are such that both power supplies are not needed. When the power subsystem is in Cold Redundant mode, only the needed power supply to support the best power delivery efficiency is ON. Any additional power supplies; including the redundant power supply, is in Cold Standby state

Each power supply has an additional signal that is dedicated to supporting Cold Redundancy; CR\_BUS. This signal is a common bus between all power supplies in the system. CR\_BUS is asserted when there is a fault in any power supply OR the power supplies output voltage falls below the Vfault threshold. Asserting the CR\_BUS signal causes all power supplies in Cold Standby state to power ON.

Enabling power supplies to maintain best efficiency is achieved by looking at the Load Share bus voltage and comparing it to a programmed voltage level from a *PMBus*\* command.

Whenever there is no active power supply on the Cold Redundancy bus driving a HIGH level on the bus all power supplies are ON no matter their defined Cold Redundant roll (active or Cold Standby). This guarantees that incorrect programming of the Cold Redundancy states of the power supply will never cause the power subsystem to shut down or become over loaded. The default state of the power subsystem is all power supplies ON. There needs to be at least one power supply in Cold Redundant Active state or Standard Redundant state to allow the Cold Standby state power supplies to go into Cold Standby state.

#### 3.6.1 Powering on Cold Standby supplies to maintain best efficiency

Power supplies in Cold Standby state shall monitor the shared voltage level of the load share signal to sense when it needs to power on. Depending upon which position (1, 2, or 3) the system defines that power supply to be in the cold standby configuration; will slightly change the load share threshold that the power supply shall power on at.

CR\_BUS De-asserted/Asserted Enable Threshold for VCR ON EN Disable Threshold for vcr on dis States Standard NA; Ignore dc/dc\_ active# signal; power supply is always OK = HighFault = Low Redundancy Cold Redundant NA; Ignore dc/dc active# signal; power supply is always OK = HighON Fault = Low Active Cold Standby 1 (02h) 3.2V (40% of max)  $3.2V \times 0.5 \times 0.9 = 1.44V$ OK = Open Fault = Low Cold Standby 2 (03h)  $5.0V \times 0.67 \times 0.9 = 3.01V$ 5.0V (62% of max) OK = Open Fault = Low Cold Standby 3 (04h) 6.7V (84% of max)  $6.7V \times 0.75 \times 0.9 = 4.52V$ OK = Open Fault = Low

Table 25. Example Load Share Threshold for Activating Supplies

#### Notes:

- 1. Maximum load share voltage = 8.0V at 100% of rated output power.
- These are example load share bus thresholds; for a given power supply, these shall be customized to maintain the best efficiency curve for that specific model.

# 3.6.2 Powering on Cold Standby supplies during a fault or over current condition

When an active power supply asserts its CR\_BUS signal (pulling it low), all parallel power supplies in cold standby mode shall power on within 100µsec.

#### 3.6.3 BMC Requirements

The BMC uses the *Cold\_Redundancy\_Config* command to define/configure the power supply's roll in cold redundancy and to turn on/off cold redundancy.

The BMC shall schedule a rolling change for which PSU is the Active, Cold Stby1, Cold Stby 2, and Cold Stby 3 power supply. This allows for equal loading across power supply over their life.

Events that trigger a re-configuration of the power supplies using the *Cold\_Redundancy\_Config* command:

- AC power ON
- PSON power ON
- Power Supply Failure
- Power supply inserted into system

#### 3.6.4 Power Supply Turn On Function

Powering on and off of the cold standby power supplies is only controlled by each PSU sensing the Vshare bus. Once a power supply turns on after crossing the enable threshold; it lowers its threshold to the disable threshold. The system defines the 'position' of each power supply in the Cold Redundant operation. It will do this each time the system is powered on, a power supply fails, or a power supply is added to the system.

The system is relied upon to tell each power supply where it resides in the Cold Redundancy scheme.

## 3.7 Closed Loop System Throttling (CLST)

The server system has support for Closed Loop System Throttling (CLST). This feature prevents the system from crashing if a power supply module is overloaded. Should system power reach a pre-programmed power limit, CLST will throttle system memory and/or

processors to reduce power. System performance will be impacted should this occur. For more in depth information about CLST implementation, please refer to the *SmaRT & CLST Architecture on "Romley" Systems and Power Supplies Specification* (IBL Reference # 461024).

#### 3.8 Smart Ride Through Throttling (SmaRT)

The server system has support for Smart Ride Through Throttling (SmaRT). This feature increases the reliability for a system operating in a heavy power load condition, to remain operational during an AC line dropout event. See section 3.5.4 for power supply hold up time requirements for AC Line dropout events.

When AC voltage is too low, a fast AC loss detection circuit inside each installed power supply asserts an SMBALERT# signal to initiate a throttle condition in the system. System throttling reduces the bandwidth to both system memory and CPUs, which in turn reduces the power load during the AC line drop out event.

#### 3.9 Power Supply Status LED

There is a single bi-color LED to indicate power supply status. The LED operation is defined in the following table:

**Power Supply Condition LED State** Output ON and OK GREEN No AC power to all power supplies OFF AC present/Only 12VSB on (PS off) or PS in Cold 1Hz Blink GREEN redundant state AC cord unplugged or AC power lost; with a second AMBER power supply in parallel still with AC input power. Power supply warning events where the power supply continues to operate; high temp, high power, high current, 1Hz Blink Amber slow fan. Power supply critical event causing a shutdown; failure, AMBER OCP, OVP, Fan Fail Power supply FW updating 2Hz Blink GREEN

**Table 26. LED Indicators** 

# 4. Thermal Management

The fully integrated system is designed to operate at external ambient temperatures of between 10°C - 35°C with limited excursion based operation up to 45°C, as specified in Table 2. Working with integrated platform management, several features within the system are designed to move air in a front to back direction, through the system and over critical components to prevent overheating and allow the system to operate with best performance.

The Intel® Server System R2000SC product family supports short-term, excursion-based, operation up to 45°C (ASHRAE A4) with limited performance impact. The configuration requirements and limitations are described in the configuration matrix found in the Intel® S2400SC Product Family Power Budget and Thermal Configuration Tool, available as a download online at http://www.intel.com/p/en\_US/support/.

The installation and functionality of several system components are used to maintain system thermals. They include three managed fixed system fans, one integrated fan for each installed power supply module, an air duct, populated hard drive carriers, and installed CPU heatsink. Hard drive carriers can be populated with a hard drive or supplied drive blank. In addition, it may be necessary to have specific DIMM slots populated with DIMMs or supplied DIMM blanks.

#### 4.1 Thermal Operation and Configuration Requirements

To keep the system operating within supported maximum thermal limits, the system must meet the following operating and configuration guidelines:

- The system operating ambient is designed for sustained operation up to 35°C (ASHRAE Class A2) with short term excursion based operation up to 45°C (ASHRAE Class A4).
  - The system can operate up to 40°C (ASHRAE Class A3) for up to 900 hours per vear
  - The system can operate up to 45°C (ASHRAE Class A4) for up to 90 hours per year
  - System performance may be impacted when operating within the extended operating temperature range
  - There is no long term system reliability impact when operating at the extended temperature range within the approved limits.
- Specific configuration requirements and limitations are documented in the configuration matrix found in the Intel® S2400SC Product Family Power Budget and Thermal Configuration Tool, available as a download online at http://www.intel.com/p/en\_US/support/.
- Memory Slot population requirements:
  - DIMM Population Rules on CPU 1 Install DIMMs in order: Channels A, B, and C, Start with the first DIMM (Blue Slot) on each channel, then second DIMM.
  - DIMM Population Rules on CPU 2 Install DIMMs in order: Channels D, E, and F, Start with the first DIMM (Blue Slot) on each channel, then second DIMM.
- All hard drive bays must be populated. Hard drive carriers can be populated with a hard drive or supplied drive blank.
- With the system operating, the air duct must be installed at all times
- The system top-cover must be installed at all times when the system is in operation.

### 4.2 Thermal Management Overview

In order to maintain the necessary airflow within the system, all of the previously listed components and top cover need to be properly installed. For best system performance, the external ambient temperature should remain below 35°C and all system fans should be operational. The system is designed for fan redundancy when the system is configured with two power supplies. Should a single system fan fail (System fan or Power Supply Fan), integrated platform management will: change the state of the System Status LED to flashing Green, report an error to the system event log, and automatically adjust fan speeds as needed to maintain system temperatures below maximum thermal limits.

**Note:** All system fans are controlled independent of each other. The fan control system may adjust fan speeds for different fans based on increasing/decreasing temperatures in different thermal zones within the chassis.

In the event that system temperatures should continue to increase with the system fans operating at their maximum speed, platform management may begin to throttle bandwidth of either the memory subsystem or the processors or both, in order to keep components from overheating and keep the system operational. Throttling of these sub-systems will continue until system temperatures are reduced below preprogrammed limits.

Should system temperatures increase to a point beyond the maximum thermal limits, the system will shut down, the System Status LED will change to a solid Amber state, and the event will be logged to the system event log.

**Note:** Sensor data records (SDRs) for any given system configuration must be loaded by the system integrator for proper thermal management of the system. SDRs are loaded using the FRUSDR utility.

An intelligent Fan Speed Control (FSC) and thermal management technology (mechanism) is used to maintain comprehensive thermal protection, deliver the best system acoustics, and fan power efficiency. Options in <F2> BIOS Setup (BIOS > Advanced > System Acoustic and Performance Configuration) allow for parameter adjustments based on the actual system configuration and usage. Refer to the following sections for a description of each setting.

### 4.2.1 Set Throttling Mode

This option is used to select the desired memory thermal throttling mechanism. Available settings include:

[Auto], [DCLTT], [SCLTT] and [SOLTT].

[Auto] – Factory Default Setting - BIOS automatically detects and identifies the appropriate thermal throttling mechanism based on DIMM type, airflow input, and DIMM sensor availability. [DCLTT] – Dynamic Closed Loop Thermal Throttling: for the SOD DIMM with system airflow input

[SCLTT] – Static Close Loop Thermal Throttling: for the SOD DIMM without system airflow input [SOLTT] – Static Open Loop Thermal Throttling: for the DIMMs without sensor on DIMM (SOD)

### 4.2.2 Altitude

This option sets the proper altitude that the system will be used. Available settings include: [300m or less], [301m-900m], [901m-1500m], [Above 1500m].

Selecting an altitude range that is lower than the actual altitude the system will be operating at, can cause the fan control system to operate less efficiently, leading to higher system thermals and lower system performance. If the altitude range selected is higher than the actual altitude the system will be operating at, the fan control system may provide better cooling but with higher acoustics and higher fan power consumption. If the altitude is not known, selecting a higher altitude is recommended in order to provide sufficient cooling.

#### 4.2.3 Set Fan Profile

This option sets the desired Fan Profile. Available settings include: **[Performance]** and [Acoustic].

The Acoustic mode offers the best acoustic experience and appropriate cooling capability supporting the majority of the add-in cards used. Performance mode is designed to provide sufficient cooling capability covering all kinds of add-in cards on the market.

#### 4.2.4 Fan PWM Offset

This option is reserved for manual adjustment to the minimum fan speed curves. The valid range is from [**0** to 100] which stands for 0% to 100% PWM adding to the minimum fan speed. This feature is valid when Quiet Fan Idle Mode is at Enabled state. The default setting is [0]

#### 4.2.5 Quiet Fan Idle Mode

This feature can be [Enabled] or **[Disabled]**. If enabled, the fans will either shift to a lower speed or stop when the aggregate sensor temperatures are satisfied, indicating the system is at ideal thermal/light loading conditions. When the aggregate sensor temperatures are not satisfied, the fans will shift back to normal control curves. If disabled, the fans will never shift into lower fan speeds or stop, regardless of whether the aggregate sensor temperatures are satisfied or not. The default setting is [Disabled]

**Note:** The above feature may or may not be in effect and depends on the actual thermal characteristics of the specified system.

### 4.2.6 Thermal Sensor Input for Fan Speed Control

The BMC uses various IPMI sensors as inputs to the fan speed control. Some of the sensors are actual physical sensors and some are "virtual" sensors derived from calculations.

The following IPMI thermal sensors are used as inputs to the fan speed control:

- Front Panel Temperature Sensor<sup>1</sup>
- CPU Margin Sensors<sup>2,4,5</sup>
- DIMM Thermal Margin Sensors<sup>2,4</sup>
- Exit Air Temperature Sensor<sup>1, 7, 9</sup>
- PCH Temperature Sensor<sup>3,5</sup>
- On-board Ethernet Controller Temperature Sensors<sup>3, 5</sup>
- Add-In Intel SAS/IO Module Temperature Sensors<sup>3, 5</sup>
- PSU Thermal Sensor<sup>3, 8</sup>
- CPU VR Temperature Sensors<sup>3, 6</sup>
- DIMM VR Temperature Sensors<sup>3, 6</sup>
- BMC Temperature Sensor<sup>3, 6</sup>
- Global Aggregate Thermal Margin Sensors<sup>7</sup>
- Hot Swap Backplane Temperature Sensors

- I/O module Temperature Sensor (with option installed)
- Intel<sup>®</sup> ROC Module (with option installed)

#### Notes:

- 1. For fan speed control in Intel® chassis
- 2. Temperature margin from throttling threshold
- 3. Absolute temperature
- 4. PECI value or margin value
- 5. On-die sensor
- 6. On-board sensor
- 7. Virtual sensor
- 8. Available only when PSU has PMBus\*
- Calculated estimate

The following diagram illustrates the fan speed control structure:

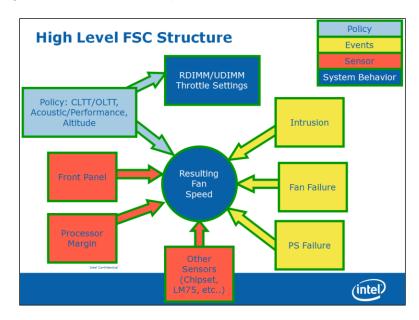


Figure 18. Fan Control Model

### 4.3 System Fans

Three 80x80x38mm fixed fans and an embedded fan for each installed power supply, provide the primary airflow for the system. The system does not support fan redundancy feature.

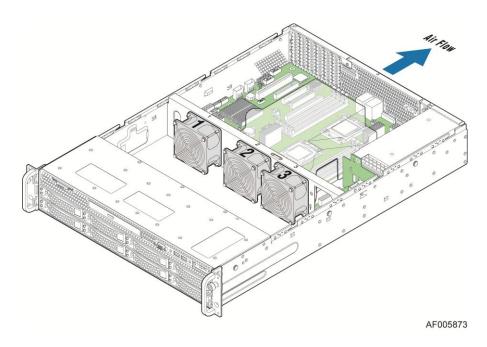


Figure 19. System Fan Identification

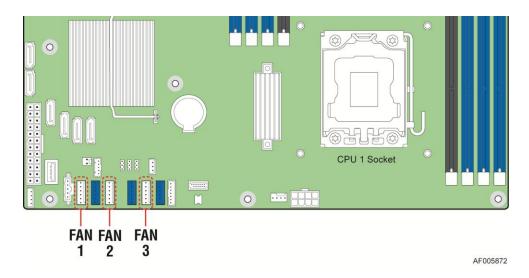


Figure 20. Server Board System Fan Connector Locations

**Table 27. System Fan Connector Pin-out** 

Pin	Signal Name	Туре	Description
1	Ground	GND	Ground is the power supply ground
2	12V	Power	Power supply 12 V
3	Fan Tach	In	FAN_TACH signal is connected to the BMC to monitor the fan speed
4	Fan PWM	Out	FAN_PWM signal to control fan speed

### 4.4 Power Supply Module Fan

Each installed power supply module includes one embedded (non-removable) 40-mm fan. It is responsible for airflow through the power supply module. This fan is managed by the fan control system. Should this fan fail, the power supply will continue to operate until its internal temperature reaches an upper critical limit. The power supply will be protected against over temperature conditions caused by loss of fan cooling or excessive ambient temperature. In an over-temperature protection condition, the power supply module will shutdown.

### 4.5 FRUSDR Utility

The purpose of the embedded platform management and fan control systems is to monitor and control various system features, and to maintain an efficient operating environment. Platform management is also used to communicate system health to supported platform management software and support mechanisms. The FRUSDR utility is used to program the server board with platform specific environmental limits, configuration data, and the appropriate sensor data records (SDRs) for use by these management features.

The FRUSDR utility must be run as part of the initial platform integration process before it is deployed into a live operating environment. It must be run with the system fully configured and each time the system configuration changes.

The FRUSDR utility for the given server platform can be run as part of the *Intel*<sup>®</sup> *Server Deployment Toolkit and Management* DVD that ships with each Intel<sup>®</sup> server, or can be downloaded from <a href="http://www.intel.com/p/en\_US/support/">http://www.intel.com/p/en\_US/support/</a>.

**Note:** The embedded platform management system may not operate as expected if the platform is not updated with accurate system configuration data. The FRUSDR utility must be run with the system fully configured and each time the system configuration changes for accurate system monitoring and event reporting.

# 5. System Storage and Peripheral Drive Bays Overview

The Intel® Server System R2000SC product family has support for the following storage device options:

- Hot Swap 3.5" Hard Disk Drives
- SATA Optical Drive
- Low Profile (2mm) eUSB Solid State Device (eUSB SSD)
- SATA DOM

### 5.1 3.5" Hard Disk Drive Support

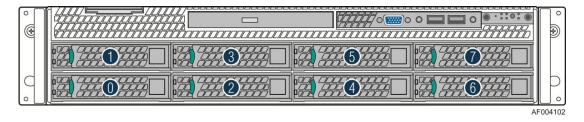


Figure 21. 3.5" Hard Drive Bay - 8 Drive Configuration

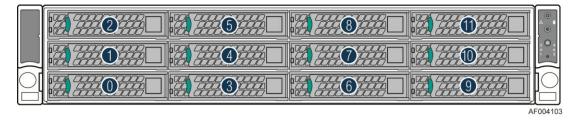


Figure 22. 3.5" Hard Drive Bay - 12 Drive Configuration

The drive bay can support either SATA or SAS hard disk drives. Mixing of drive types within the hard drive bay is not supported. Hard disk drive type is dependent on the type of host bus controller used, SATA only or SAS. Each 3.5" hard disk drive is mounted to a drive tray, allowing for hot swap extraction and insertion. Drive trays have a latching mechanism that is used to extract and insert drives from the chassis and lock the tray in place.

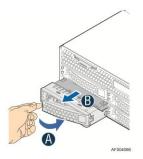
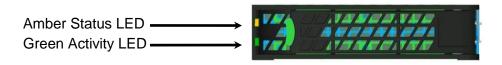


Figure 23. Removing 3.5" Hard Drive Bay

Light pipes integrated into the drive tray assembly direct light emitted from the Amber drive status and Green activity LEDs located next to each drive connector on the backplane, to the drive tray faceplate, making them visible from front of the system.



	Off	ff No access and no fault		
Amber	Solid On	Hard Drive Fault has occurred		
	Blink	RAID rebuild in progress (1 Hz), Identify (2 Hz)		

	Condition	Drive Type	Behavior
	Power on with no drive activity	SAS	LED stays on
	Power on with no drive activity	SATA	LED stays off
	Dower on with drive activity	SAS	LED blinks off when processing a command
Green	Power on with drive activity	SATA	LED blinks on when processing a command
	Power on and drive spun down	SAS	LED stays off
	Power on and unive spun down	SATA	LED stays off
	Power on and drive spinning up	SAS	LED blinks
	Fower on and unive spinning up	SATA	LED stays off

Figure 24. Hot Swap Drive Bay LEDs

### 5.1.1 3.5" Drive Hot Swap Backplane Overview

Systems with 8 or 12 drive configurations have their own unique backplane. Both 8 and 12 drive backplanes share identical features. The following will be used to describe the features of both backplanes. Differences between the two will be noted.

The backplanes mount to the back of the drive bay assembly.

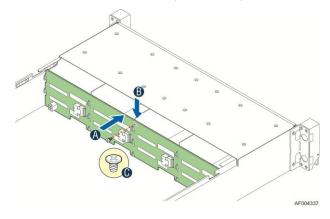


Figure 25. Installing 3.5" Hot Swap Backplane

On the front side of each back plane are mounted eight or twelve hard disk drive interface connectors, each providing both power and I/O signals to the attached hard disk drives.

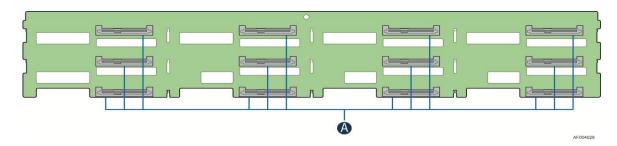
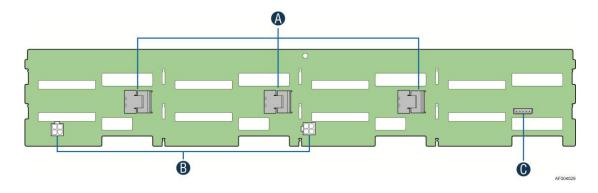


Figure 26. 3.5" Hot Swap Backplane Front View

On the backside of each backplane are several connectors. The following illustration identifies each of them:



Label	Description		
Α	4-port mini-SAS connectors		
В	Power connectors		
С	SMBus* connector		

Figure 27. 3.5" Hot Swap Backplane Back View

**A –** 4-port Mini-SAS Connectors: The backplane includes two or three multi-port mini-SAS cable connectors, each providing SGPIO and I/O signals for four SAS/SATA hard drives on the backplane. Cables can be routed from matching connectors on the server board, add-in SAS/SATA RAID cards, or an optionally installed SAS expander card. Each mini-SAS connector will include a silk-screen identifying which drives the connector supports; Drives 0-3, Drives 4-7, and Drives 8-11.

**B** – Power Harness Connector: The backplane includes a 2x2 connector supplying power to the backplane. Power is routed to the backplane from a power cable harness from the server board.

**C** – SMBus\* Cable Connectors: The backplane includes a 1x5 cable connector used as a management interface to the server board.

### 5.1.2 Cypress\* CY8C22545 Enclosure Management Controller

The backplanes support enclosure management using a Cypress\* CY8C22545 Programmable System-on-Chip (PSoC\*) device. The CY8C22545 drives the hard drive activity/fault LED, hard drive present signal, and controls hard drive power-up during system power-on.

### 5.2 Optical Drive Support

System configured with eight 3.5" hard drive bays also includes support for an optical drive bay **A** as illustrated below:

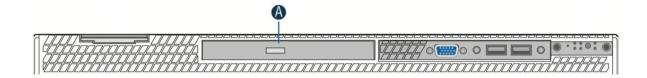


Figure 28. Optical Drive Support

SATA signals for either option are cabled from the white 7-pin single port AHCI SATA connector labeled **AHCI SATA 0** or **AHCI SATA 1** on the server board.

### **5.3 SATA DOM Support**

The system has support for a vertical low profile Innodisk\* SATA Disk-on-Module (DOM) device.

The SATA DOM plugs directly into the 7-pin AHCI SATA port on the server board, which provides both power and I/O signals.



Figure 29. InnoDisk\* Low Profile SATA DOM

SATA DOM features include:

- Ultra low Profile
- High Speed and Capacity
- Built-in VCC at pin 7

Note: Visit http://www.intel.com/p/en\_US/support/ for a list of supported SATA DOM parts.

### 6. Storage Controller Options Overview

The server platform supports many different embedded and add-in SATA/SAS controller and SAS Expander options to provide a large number of possible storage configurations. This section will provide an overview of the different options available.

### **6.1 Embedded SATA/SAS Controller support**

The Intel® C602 (-A) chipset provides storage support from two integrated controllers: AHCI and SCU. By default the server board will support two single 6Gb/sec SATA ports routed from the AHCI controller to the two white SATA connectors labeled **SATA\_0** and **SATA\_1**, four 3Gb/sec SATA ports routed from the AHCI controller to the four black SATA connectors labeled **SATA\_2** to **SATA\_5**, and four 3Gb/sec SATA ports routed from the SCU to the four SATA/SAS connectors labeled **SATA/SAS 0** to **SATA/SAS 3**.

**Note**: The SATA/SAS connector labeled **SATA/SAS\_4** to **SATA/SAS\_7** is NOT functional by default and is only enabled with the addition of an Intel<sup>®</sup> RAID C600 Upgrade Key option supporting eight SAS/SATA ports.

With the addition of one of several available Intel® RAID C600 Upgrade Keys, the system is capable of supporting additional embedded SATA, SAS, and software RAID options. Upgrade keys install onto a 4-pin connector on the server board labeled **STOR\_UPG\_KEY**.

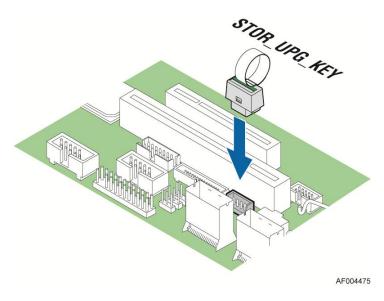


Figure 30. Intel® RAID C600 Upgrade Key Connector

The following table identifies available upgrade key options and their supported features:

Table 28. Intel® RAID C600 Upgrade Key Options

Intel® RAID C600 Upgrade Key	Key Color	Description
(Intel Product Codes)		(9)
Default – No option key	N/A	4 Port SATA with Intel® ESRT RAID 0,1,10 and Intel® RSTe RAID
installed		0,1,5,10
RKSATA4R5	Black	4 Port SATA with Intel <sup>®</sup> ESRT2 RAID 0,1, <b>5</b> , 10 and Intel <sup>®</sup> RSTe
		RAID 0,1,5,10
RKSATA8	Blue	8 Port SATA with Intel <sup>®</sup> ESRT2 RAID 0,1, 10 and Intel <sup>®</sup> RSTe
		RAID 0,1,5,10
RKSATA8R5	White	8 Port SATA with Intel <sup>®</sup> ESRT2 RAID 0,1, <b>5</b> , 10 and Intel <sup>®</sup> RSTe
		RAID 0,1,5,10
RKSAS4	Green	4 Port SAS with Intel® ESRT2 RAID 0,1, 10 and Intel® RSTe RAID
		0,1,10
RKSAS4R5	Yellow	4 Port SAS with Intel® ESRT2 RAID 0,1, 5, 10 and Intel® RSTe
		RAID 0,1,10
RKSAS8	Orange	8 Port SAS with Intel® ESRT2 RAID 0,1, 10 and Intel® RSTe RAID
		0,1,10
RKSAS8R5	Purple	8 Port SAS with Intel <sup>®</sup> ESRT2 RAID 0,1, <b>5</b> , 10 and Intel <sup>®</sup> RSTe
	'	RAID 0,1,10

Additional information for the on-board RAID features and functionality can be found in the *Intel*<sup>®</sup> *RAID Software Users Guide* (Intel<sup>®</sup> Document Number D29305).

### 6.2 Embedded Software RAID Support

The system includes support for two embedded software RAID options:

- Intel<sup>®</sup> Embedded Server RAID Technology 2 (ESRT2) based on LSI\* MegaRAID SW RAID technology
- Intel<sup>®</sup> Rapid Storage Technology (RSTe)

Using the <F2> BIOS Setup Utility, accessed during system POST, options are available to enable/disable SW RAID, and select which embedded software RAID option to use.

### 6.2.1 Intel<sup>®</sup> Embedded Server RAID Technology 2 (ESRT2)

Features of the embedded software RAID option Intel<sup>®</sup> Embedded Server RAID Technology 2 (ESRT2) include the following:

- Based on LSI\* MegaRAID Software Stack
- Software RAID with system providing memory and CPU utilization
- Supported RAID Levels 0,1,5,10
  - 4 and 8 Port SATA RAID 5 support provided with appropriate Intel<sup>®</sup> RAID C600 Upgrade Key
  - 4 and 8 Port SAS RAID 5 support provided with appropriate Intel<sup>®</sup> RAID C600 Upgrade Key
- Maximum drive support = 8

Note: ESRT2 has no SAS Expander Support.

- Open Source Compliance = Binary Driver (includes Partial Source files)
  - Meta data is also recognized by MDRAID layer in Linux\* (No direct Intel<sup>®</sup> support, not validated by Intel<sup>®</sup>)

- OS Support = Microsoft Windows 7\*, Microsoft Windows 2008\*, Microsoft Windows 2003\*, RHEL\*, SLES\*, other Linux\* variants using partial source builds.
- Utilities = Microsoft Windows\* GUI and CLI, Linux\* GUI and CLI, DOS CLI, and EFI CLI

### 6.2.2 Intel<sup>®</sup> Rapid Storage Technology (RSTe)

Features of the embedded software RAID option Intel<sup>®</sup> Rapid Storage Technology (RSTe) include the following:

- Software RAID with system providing memory and CPU utilization
- Supported RAID Levels 0,1,5,10
  - 4 Port SATA RAID 5 available standard (no option key required)
  - 8 Port SATA RAID 5 support provided with appropriate Intel<sup>®</sup> RAID C600 Upgrade Key
  - No SAS RAID 5 support
- Maximum drive support = 32 (in arrays with eight port SAS), 16 (in arrays with four port SAS), 128 (JBOD)
- Open Source Compliance = Yes (uses MDRAID)
- OS Support = Microsoft Windows 7\*, Microsoft Windows 2008\*, Microsoft Windows 2003\*, RHEL\*, SLES\*, VMware\* 5.x
- Utilities = Microsoft Windows\* GUI and CLI, Linux\* CLI, DOS CLI, and EFI CLI
- Uses Matrix Storage Manager for Microsoft Windows\*
- MDRAID supported in Linux\* (Does not require a driver)

Note: No boot drive support to targets attached through SAS expander card.

**Note:** See latest product errata list for Linux\* support status. Product Errata are documented in the *Intel*® *Server Board S2400SC*, *Intel*® *Server System R2000SC Monthly Specification Update* which can be downloaded from <a href="http://www.intel.com/p/en\_US/support/">http://www.intel.com/p/en\_US/support/</a>.

Visit <a href="http://www.intel.com/p/en\_US/support/">http://www.intel.com/p/en\_US/support/</a> for a list of supported operating systems.

### 6.3 Intel<sup>®</sup> Integrated RAID Module Support (Available Option)

The system has support for several Intel® Integrated RAID Modules.

Note: The RAID adapter can be installed into any available PCIe slot except for PCIe slot 3.

Table 29. Supported Intel<sup>®</sup> Integrated RAID Modules

External Name	Description	Product Code
Intel <sup>®</sup> Integrated RAID Module RMS25PB080	SATA 6GB, 8 port internal, Enterprise RAID, PCIe	RMS25PB080
Intel <sup>®</sup> Integrated RAID Module RMS25PB040	SAS 6GB, 4 port internal, Enterprise RAID, PCIe	RMS25PB040
Intel® Integrated RAID Module RMT3PB080	SAS 6GB, 8 port internal, Enterprise RAID, PCIe	RMT3PB080
Intel <sup>®</sup> Integrated RAID Module RMS25KB080	SAS 6GB, 8 port internal, LSI2308, Value RAID, PCIe	RMS25KB080
Intel <sup>®</sup> Integrated RAID Module RMS25KB040	SAS 6GB, 4 port internal, LSI2308, Value RAID, PCIe	RMS25KB040

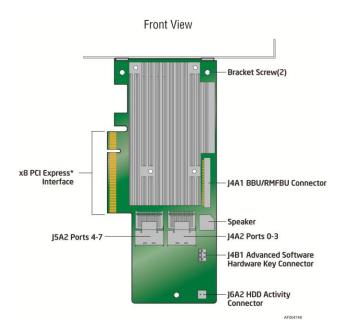


Figure 31. Intel® Integrated RAID Module

For additional product information, please refer the following Intel® documents:

- Intel® Integrated RAID Module RMS25PB040, RMS25PB080, RMT3PB080, RMS25KB080 and RMS25KB040 Hardware/Installation Users Guide
- Intel® Raid Maintenance Free Backup Unit AXXRMFBU2 Users Guide

### **6.4** SAS Expander Support Options

The system is designed to support SAS Expander cards for storage configurations that require more than eight hard disk drives.

Intel® SAS Expander	Installation type	Hard Drive Configuration
24 Port PCle Intel <sup>®</sup> RAID Expander Card RES2SV240	PCIe add-in card	3.5" Hard Disk drive bay configurations

#### Intel® RAID Expander Features:

- SAS protocol, described in the Serial Attached SCSI (SAS) Standard, version 2.0
- Serial SCSI Protocol (SSP) to enable communication with other SAS devices
- Serial Tunneling Protocol (STP) support for SATA II through expander interfaces
- Serial Management Protocol (SMP) to share topology management information with expanders
- Supports SES for enclosure management
- Output mini-SAS connectors support sideband SGPIO as per SFF-8485 Specification
- Supports both Serial Attached SCSI and Serial ATA device targets
- 6.0 Gbit/s, 3.0 Gbit/s, and 1.5 Gbit/s data transfer rate
- SFF-8087 mini-SAS connectors
- Provides a low-latency connection to create and maintain transparent access to each connected SAS/SATA physical drive
- Staggered spin-up

- Hot Plug
- Native Command Queuing
- Allows multiple initiators to address a single target (in a fail-over configuration)

### 6.4.1 24-Port PCle Intel® RAID Expander Card RES2SV240

For large storage configurations that include a drive bay supporting twelve 3.5" hard disk drives, a 24-Port PCIe Intel<sup>®</sup> RAID Expander Card RES2SV240 may be installed into any available PCIe add-in slot.

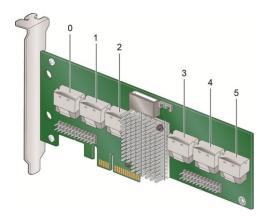


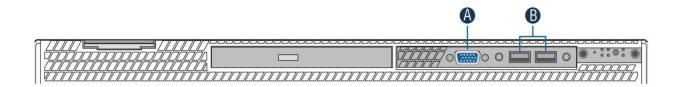
Figure 32. 24 Port PCle Intel® RAID Expander Card RES2SV240

For additional information on the Intel<sup>®</sup> RAID Expander Card RES2SV240, please refer the *Intel<sup>®</sup> RAID Expander Card RES2SV240 Hardware Users Guide* (Intel<sup>®</sup> Document Order # E93121).

### 7. Front Control Panel and I/O Panel Overview

All system configurations will include a Control Panel on the front of the system providing push button system controls and LED indicators for several system features. Systems configured with eight 3.5" hard drive bays will also include an I/O Panel providing additional system I/O features. This section describes the features and functions of the front panel option.

### 7.1 I/O Panel Features



Label	Description
Α	Video connector
В	USB ports

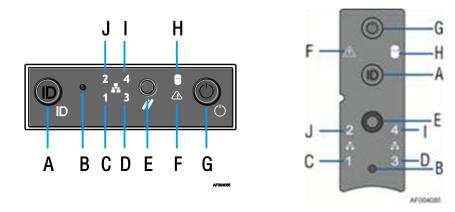
Figure 33. Front I/O Panel Features

**A – Video connector**: Not used on R2000SC system.

**B** – **USB Ports**: The front I/O panel includes two USB ports. The USB ports are cabled to a 2x5 connector on the server board labeled **FP USB**.

### 7.2 Control Panel Features

The system includes a control panel that provides push button system controls and LED indicators for several system features. Depending on the hard drive configuration, the front control panel may come in either of two formats; however, both provide the same functionality. This section will provide a description for each front control panel feature.



Label	Description	Label	Description
Α	System ID Button w/Integrated LED	F	System Status LED
В	NMI Button (recessed, tool required for use)	G	Power / Sleep Button w/Integrated LED
С	NIC-1 Activity LED	Н	Hard Drive Activity LED
D	NIC-3 Activity LED	I	NIC-4 Activity LED
Е	System Cold Reset Button	J	NIC-2 Activity LED

**Figure 34. Front Control Panel Features** 

- **A System ID Button w/Integrated LED**: Toggles the integrated ID LED and the Blue server board ID LED on and off. The System ID LED is used to identify the system for maintenance when installed in a rack of similar server systems. The System ID LED can also be toggled on and off remotely using the *IPMI Chassis Identify* command which will cause the LED to blink for 15 seconds.
- **B NMI Button**: When the NMI button is pressed, it puts the server in a halt state and issues a non-maskable interrupt (NMI). This can be useful when performing diagnostics for a given issue where a memory download is necessary to help determine the cause of the problem. To prevent an inadvertent system halt, the actual NMI button is located behind the Front Control Panel faceplate where it is only accessible with the use of a small tipped tool like a pin or paper clip.
- **C, D, I and J Network Activity LEDs**: The Front Control Panel includes an activity LED indicator for each on-board Network Interface Controller (NIC). When a network link is detected, the LED will turn on solid. The LED will blink once network activity occurs at a rate that is consistent with the amount of network activity that is occurring.
- **E System Cold Reset Button**: When pressed, this button will reboot and re-initialize the system.

**F – System Status LED**: The System Status LED is a bi-color (Green/Amber) indicator that shows the current health of the server system. The system provides two locations for this feature; one is located on the Front Control Panel, the other is located on the back edge of the server board, viewable from the back of the system. Both LEDs are tied together and will show the same state. The System Status LED states are driven by the on-board platform management sub-system. The following table provides a description of each supported LED state:

Table 30. System Status LED State Definitions

Color	State	Criticality	Description
Off	System is not operating		System is powered off (AC and/or DC). System is in EuP Lot6 Off Mode. System is in S5 Soft-Off State. System is in S4 Hibernate Sleep State.
Green	Solid on	Ok	Indicates that the System is running (in S0 State) and its status is 'Healthy'. The system is not exhibiting any errors. AC power is present and BMC has booted and manageability functionality is up and running.
Green	~1 Hz blink	Degraded - system is operating in a degraded state although still functional, or system is operating in a redundant state but with an impending failure warning	System degraded: Redundancy loss, such as power-supply or fan. Applies only if the associated platform sub-system has redundancy capabilities. Fan warning or failure when the number of fully operational fans is more than minimum number needed to cool the system. Non-critical threshold crossed – Temperature (including HSBP temp), voltage, input power to power supply, output current for main power rail from power supply and Processor Thermal Control (Therm Ctrl) sensors. Power supply predictive failure occurred while redundant power supply configuration was present. Unable to use all of the installed memory (one or more DIMMs failed/disabled but functional memory remains available) Correctable Errors over a threshold and migrating to a spare DIMM (memory sparing). This indicates that the user no longer has spared DIMMs indicating a redundancy lost condition. Corresponding DIMM LED lit. Uncorrectable memory error has occurred in memory Mirroring Mode, causing Loss of Redundancy. Correctable memory error threshold has been reached for a failing DDR3 DIMM when the system is operating in fully redundant RAS Mirroring Mode. Battery failure. BMC executing in uBoot. (Indicated by Chassis ID blinking at Blinking at 3Hz). System in degraded state (no manageability). BMC uBoot is running but has not transferred control to BMC Linux*. Server will be in this state 6-8 seconds after BMC reset while it pulls the Linux* image into flash BMC booting Linux*. (Indicated by Chassis ID solid ON). System in degraded state (no manageability). Control has been passed from BMC uBoot to BMC Linux* itself. It will be in this state for ~10-~20 seconds. BMC Watchdog has reset the BMC. Power Unit sensor offset for configuration error is asserted. HDD HSC is off-line or degraded.

Color	State	Criticality	Description
Amber	~1 Hz blink	Non-critical - System is operating in a degraded state with an impending failure warning, although still functioning	Non-fatal alarm – system is likely to fail: Critical threshold crossed – Voltage, temperature (including HSBP temp), input power to power supply, output current for main power rail from power supply and PROCHOT (Therm Ctrl) sensors. VRD Hot asserted. Minimum number of fans to cool the system not present or failed Hard drive fault Power Unit Redundancy sensor – Insufficient resources offset (indicates not enough power supplies present) In non-sparing and non-mirroring mode if the threshold of correctable errors is crossed within the window Correctable memory error threshold has been reached for a failing
Amber	Solid on	Critical, non-recoverable – System is halted	Fatal alarm – system has failed or shutdown: CPU CATERR signal asserted MSID mismatch detected (CATERR also asserts for this case). CPU 1 is missing CPU Thermal Trip No power good – power fault DIMM failure when there is only 1 DIMM present and hence no good memory present. Runtime memory uncorrectable error in non-redundant mode. DIMM Thermal Trip or equivalent SSB Thermal Trip or equivalent CPU ERR2 signal asserted BMC\Video memory test failed. (Chassis ID shows blue/solid-on for this condition) Both uBoot BMC FW images are bad. (Chassis ID shows blue/solid-on for this condition) 240VA fault Fatal Error in processor initialization: Processor family not identical Processor core/thread counts not identical Processor cache size not identical Unable to synchronize QPI link frequency

**G – Power/Sleep Button**: Toggles the system power on and off. This button also functions as a sleep button if enabled by an ACPI compliant operating system. Pressing this button will send a signal to the Integrated BMC, which will either power on or power off the system. The integrated LED is a single color (Green) and is capable of supporting different indicator states as defined in the following table:

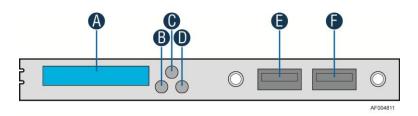
Table 31. Power/Sleep LED Functional States

State	Power Mode	LED	Description
Power-off	Non-ACPI	Off	System power is off, and the BIOS has not initialized the chipset.
Power-on	Non-ACPI	On	System power is on
S5	ACPI	Off	Mechanical is off, and the operating system has not saved any context to the hard disk.
S4	ACPI	Off	Mechanical is off. The operating system has saved context to the hard disk.
S3-S1	ACPI	Slow blink	DC power is still on. The operating system has saved context and gone into a level of low-power state.
S0	ACPI	Steady on	System and the operating system are up and running.

**H – Drive Activity LED**: The drive activity LED on the front panel indicates drive activity from the on-board hard disk controllers. The server board also provides a header giving access to this LED for add-in controllers.

### 8. Intel<sup>®</sup> Local Control Panel

The Intel<sup>®</sup> Local Control Panel option (Intel<sup>®</sup> Product Order Code – AXXLCPANEL) utilizes a combination of control buttons and LCD display to provide system accessibility and monitoring.





Label	Description	Functionality
Α	LCD Display	one line 18 character display
В	Left Control Button	moves the cursor backward one step or one character
С	"Enter" Button	selects the menu item highlighted by the cursor
D	Right Control Button	moves the cursor forward one step or one character
E	USB 2.0 Port	
F	USB 2.0 Port	

Figure 35. Intel<sup>®</sup> Local Control Panel Option

The LCD (Local Control Display) is a one line character display that resides on the front panel of the chassis. It can display a maximum of 18 characters at a time. This device also contains three buttons (Left, Right, and Enter). The user can select the content that needs to be displayed on the LCD screen by operating these buttons.

### 8.1 LCD Functionality

The LCD device provides the following features:

- Displays a banner when the system is healthy. The default banner is the server name.
- Displays active error messages when the system is not healthy.
- Provides basic server management configuration.
- Provides the ability to see asset information without having to open the chassis.

The LCD display is menu driven. Based on the user's selection, respective menu items are displayed. As soon as AC Power is applied to the system, the LCD panel displays faults detected while the system is on standby power prior to DC power on. If there are no faults, a banner is displayed. By default the banner is a text string which displays the **Server Name**. The **Server Name** is the value specified as the product name in the product FRU information in the BMC FRU. Users can set any of the parameters under the banner configuration menu as a banner string.

When the system's status is degraded, the corresponding active event will be displayed in place of the banner. During an error, the background color will be light amber in color. The LCD panel displays the event with the highest severity that is most recent and is currently active (that is, in an asserted state). For the case that there are multiple active events with the same severity, the most recent event will be displayed. The LCD panel returns to a light blue background when there are no longer any degraded, non-fatal, or fatal events active. The LCD panel shall operate in lock-step with the system status LED. For example, if the system is operating normally and an event occurs that results in the system status LED to blink green, then the LCD shall display the degraded event that triggered the systems status LED to blink.



Figure 36. LCP Background color during normal operation



Figure 37. LCP Background color during an error

If the user presses any button after the system is powered on, then the main menu will be displayed. The main menu contains **Error**, **View** and **Config** items. Based on the user's selection, respective sub menu items will be displayed. At any point of time, if there is no user intervention for more than 10 min, a default banner (if there is no active error event in the system) or an error event will be displayed.

The following sections discuss the individual menu items. In the following sections, it is assumed that no active event exists during the LCD display. If any event (fatal or non-fatal) occurs that degrades the system's performance, the color of the LCD background turns into light amber. Even though all the contents (full text) are shown in the example screen shots in the following sections, by default, only the first 18 characters are displayed when a particular menu item is selected. The remaining text can be viewed by using right or left buttons.

#### 8.2 Main Menu

If the user presses any button, when the **Banner/Error** screen is displayed, the following main menu will get displayed. Using left and right scroll buttons, the cursor can be moved under any one of the following four menu items.



Figure 38. LCP Main Menu

If the user selects menu item, ^, then the LCD displays the previous screen, that is, Banner/Error string. Selecting the menu item means, moving the cursor under that item using left or right buttons and pressing enter button subsequently. In all the following sections (or for any screen shot), if the user presses **Enter** button, when the curser is under the symbol, "^", it takes to the previous screen. Selection of any of the menu items; **Event**, **View** or **Config**, leads the display to their corresponding screen shots and the details of these screen shots are given in the following sections.

### 8.3 Event Menu

In the **Event** menu, the LCD displays all active error events in human readable text in chronological order. Informational events will not be displayed. There is no upper limit on the number of active events which can be displayed. The severity of the event will be indicated as either **Degraded**, **Non-Fatal** or **Fatal**.

Figure 39. LCP Event Menu

The menu items, <- and -> are used to traverse among the events. Selection of the menu item, <-, displays the previous event and the item, ->, displays the next event in human readable format. By default the first event after the last power on will be displayed. If there are no events after the last power on, then fourth field is empty on the LCD screen.

By default, each error event scrolls automatically so that the entire error message can be read without pressing either the left or right scroll buttons. To stop auto scrolling, cursor has to be brought under the event message and the right button has to be pressed. Then the screen freezes. To start scrolling again right button has to be pressed when the cursor is under the event message. So, when the cursor is under event message, the right button decides whether to scroll or freeze the display of event message on the screen. When the cursor is under the event message, pressing enter button displays the failing FRU (if any) in an easily human readable format for that error event. Pressing enter button alternatively switches the display between error message and the failing FRU (if any) information of that error message alternatively. If there is no FRU device associated with that error, then enter button has no effect when the cursor is under the error message. Left button moves the cursor under the previous token or menu item, that is, ->.

#### 8.4 View Menu

The following screen is displayed when **View** is selected from the main menu.

```
^ | SysFwVer | SysInfo | BMC IP Conf |
RMM4 IP Config | Power | Last PC
```

Figure 40. LCP View Menu

Based on the user's selection, details of the specific item will be displayed. The following sub sections explain the above menu items in detail.

### 8.4.1 System FW Version (SysFwVer)

Selection of the **SysFwVer** item in the **View** menu displays the current firmware versions of the system as shown below:

^ | BIOS = xx.xx | BMC = xx.xx | ME = xx.xx | FRUSDR = xx.xx

Figure 41. System Firmware Versions Menu

This is a leaf node and there is no further traversal below this menu. User can only go to the previous screen by selecting the item, ^. This applies to all the items of **View** menu.

### 8.4.2 System Information (SysInfo)

Selection of **SysInfo** item in the **View** menu displays the server's name, model, GUID, asset tag and custom string. It is also a leaf node like above menu. The blanks in the following display will be replaced by their values.

```
^ | Server Name: ...... | Server Model: ..... | Asset Tag: ..... | Server GUID: .... | Custom String: .......
```

Figure 42. System Information menu

Each of the above fields is explained below:

- Server Name: Value specified in the product name in the product FRU information in the main board BMC FRU.
- Server Model: Value specified in the product part number in the product FRU information in the main board BMC FRU.
- Asset Tag: Value specified in the product asset tag in the product FRU information in the main board BMC FRU.
- Server GUID: System UUID stored by BIOS.
- Custom String: Custom string placed by the OEM\end user.

### 8.4.3 BMC IP Configuration

Selection of **BMC IP Conf** item in the **View** menu displays the RMM4 IP configuration details. These details show whether the IP is configured using DHCP or **Static**, **IP Address**, **Subnet Mask**, and **Gateway**.

```
^ | DHCP (or Static) | IP Address:
xxx.xxx.xxx.xxx | Subnet Mask:
xxx.xxx.xxx.xxx | Gateway:
xxx.xxx.xxx.xxx
```

Figure 43. LCP - BMC IP Configuration

### 8.4.4 RMM4 IP Configuration

Selection of **RMM4 IP Conf** item in the **View** menu displays the BMC IP configuration details. These details show whether the IP is configured using DHCP or **Static**, **IP Address**, **Subnet Mask**, and Gateway.

```
^ | DHCP (or Static) | IP Address:
xxx.xxx.xxx.xxx | Subnet Mask:
xxx.xxx.xxx.xxx | Gateway:
xxx.xxx.xxx.xxx
```

Figure 44. LCP - RMM4 IP Configuration

#### 8.4.5 **Power**

Selection of **Power** item in the **View** menu displays the amount of AC power drawn by the system in Watts.



Figure 45. LCP - Power consumed by the System currently

### 8.4.6 Last Post Code (Last PC)

Selection of Last PC item in the View menu displays the last BIOS POST code in hexadecimal.

^ | XX (Last BIOS POST Code in Hex)

Figure 46. LCP – Last BIOS Post Code

### 8.5 Config Menu

If the user selects **Config** item in the main menu, then the following options will be displayed to configure:

^ | IP Version | BMC IP | RMM4 IP | Boot Device | Banner

Figure 47. LCP - Configure Menu Items

The following sub-sections will explain individual items of the configuration menu.

#### 8.5.1 IP Version

If the user selects **IP Version** in the **Config** menu, the following options will be displayed. Based the user's selection, firmware will set the IP Version as either IPv4 or IPv6.

^ | IPv4 | IPv6

Figure 48. LCP - IP Version Configuration Screen

### 8.5.2 BMC IP

If the user selects **BMC IP** item, in the **Config** menu then the following options will be displayed:

^ | IP Source | IP Address | Subnet | Gateway

### Figure 49. LCP - BMC IP Configuration Menu

Selection of the **IP Source** in the above menu, leads to the following screen. Based on the user's selection in the following menu, the firmware sets the BMC IP source as either DHCP or Static.



Figure 50. LCP – BMC IP Source Configuration Menu

If the user selects DHCP or the existing IP source is DHCP, then the other menu items, that is, IP Address, Subnet and Gateway are not configurable. If the user selects Static or the existing setting is static for IP source, then the user is allowed to change the other menu items and the screen shots look as follows:

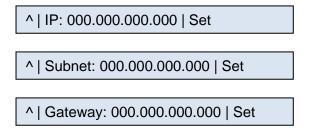


Figure 51. Screen shots for Configuring IP Address, Subnet Mask and Gateway

By default, the cursor will be under the symbol, ^ and the IP address is displayed as 000.000.000.000. A right button will take the cursor to the first position (first 0) of the IP address. When the cursor is under the second menu item, the functionality of the left, right and enter buttons will be different from the previous screens. The second token consists of twelve zeroes separated by '.' character in IP address format. The behaviors of these buttons are as follows when the cursor is under this item.

- Left and Right buttons inside the second menu item traverses among the 0 positions within the same item.
- If the cursor is under last position inside the second menu item, then a right button will move the cursor to next item, that is, **Set**.
- If the cursor is under first position inside the second menu item, then a left button moves the cursor to the previous item, that is, ^.
- First Enter button at any "0" position makes that position to be selected to increment or decrement the value at that position. The values allowed are between and including 0 and 9.
- Any further Left or Right buttons will decrement or increment the value at that position.
- Second Enter button at that position makes the cursor to be ready for moving left or right. Any further Left or Right moves the cursor to previous or next position respectively.
- So, the Enter button is used to select a position at the first time and to leave the position at the second time.

The following state transition diagram explains the above steps pictorially, while setting an IP address using the LCD device. After entering an IP address, the user has to select **Set** item to set the entered IP address to the corresponding parameter (**IP Address**, **Subnet Mask** or **Gateway**).

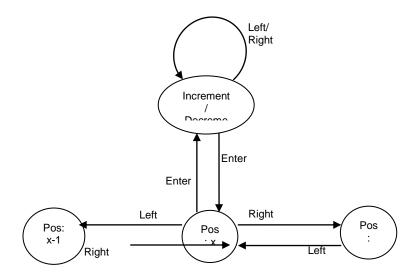


Figure 52. State transition diagram for setting IP Address

### 8.5.3 RMM4 IP

Same screen shots and the same description as that of the previous section (**BMC IP**) are applicable for **RMM4 IP** configuration menu as well.

#### 8.5.4 Boot Device

If the user selects **Boot Device** in the **Config** menu, then the following options will be displayed. The selected item will be set as the next boot option and it will not be a permanent change.

^ | CD\DVD | Hard Drive | Network Boot | EFI Shell

Figure 53. Boot options configuration menu

### 8.5.5 **Banner**

When the user selects **Banner** in the **Config** menu, the following options will be displayed. The selected item will be set as banner and the same will be displayed from next banner screen onwards.

^ | Server Name | Server Model | Error | BMC IP | RMM4 IP | Power | Last PC | Custom String | Custom Logo

Figure 54. Banner configuration menu

Each of the menu items are explained below:

- **Server Name:** Displays the value specified in the product name in the product FRU information in the main board BMC FRU. The **Server Name** is the default banner.
- Server Model: Displays the value specified in the product part number in the product FRU information in the main board BMC FRU.
- Error: Displays the last active system event. The last active event may be degraded, non-critical or critical only. It will not display an informational message. If the system is healthy then displays System Health Ok.
- **BMC IP:** Displays the IPv4 or IPv6 address of BMC IP. If the BMC IP address is not configured, then nothing is displayed.
- RMM4 IP: Displays the IPv4 or IPv6 address of RMM4 dedicated LAN IP. If the RMM4 IP is not set or not present, then nothing is displayed.
- Power: Displays the current system power consumption in watts. The power consumed will be refreshed every minute.
- Last PC: Displays last BIOS post code.
- Custom string: Displays a customizable text string. The custom text string is modifiable through BIOS setup.
- **Custom Logo:** Displays a customizable bitmap logo. The OEM customized logo is programmed by the OEM and will be maintained during subsequent firmware updates

### Appendix A: Integration and Usage Tips

This section provides a list of useful information that is unique to the Intel<sup>®</sup> Server System R2000SC Product Family and should be kept in mind while configuring your server system.

- Only the Intel<sup>®</sup> Xeon<sup>®</sup> processor E5-2400 product family is supported in this Intel<sup>®</sup> server system. Previous generation Intel<sup>®</sup> Xeon<sup>®</sup> processors are not supported.
- For best system performance, follow memory population guidelines as specified in the Intel® Server Board S2400SC Technical Product Specification.
- For best system performance, follow all thermal configuration guidelines as specified in this document.
- Many integrated on-board SAS and RAID options are available by installing any of several available Intel<sup>®</sup> RAID C600 Upgrade Keys.
- The embedded platform management system may not operate as expected if the
  platform is not updated with accurate system configuration data. The FRUSDR utility
  must be run with the system fully configured and each time the system configuration
  changes for accurate system monitoring and event reporting.
- Make sure the latest system software is loaded on the server. This includes System BIOS, BMC Firmware, ME Firmware and FRUSDR. The latest system software can be downloaded from the <a href="http://www.intel.com/p/en">http://www.intel.com/p/en</a> US/support/ website.

### Appendix B: POST Code Diagnostic LED Decoder

As an aid to assist in trouble shooting a system hang that occurs during a system's Power-On Self Test (POST) process, the server board includes a bank of eight POST Code Diagnostic LEDs on the back edge of the server board.

During the system boot process, Memory Reference Code (MRC) and System BIOS execute a number of memory initialization and platform configuration processes, each of which is assigned a specific hex POST code number. As each routine is started, the given POST code number is displayed to the POST Code Diagnostic LEDs on the back edge of the server board.

During a POST system hang, the displayed post code can be used to identify the last POST routine that was run prior to the error occurring, helping to isolate the possible cause of the hang condition.

Each POST code is represented by eight LEDs; four Green and four Amber. The POST codes are divided into two nibbles, an upper nibble and a lower nibble. The upper nibble bits are represented by Amber Diagnostic LEDs #4, #5, #6, #7. The lower nibble bits are represented by Green Diagnostics LEDs #0, #1, #2 and #3. If the bit is set in the upper and lower nibbles, the corresponding LED is lit. If the bit is clear, the corresponding LED is off.

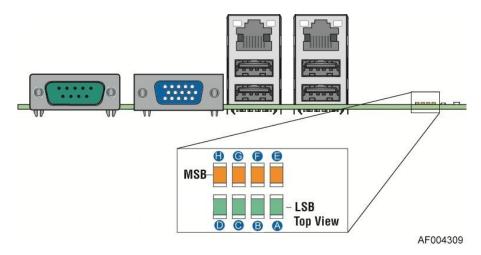


Figure 55. POST Diagnostic LED Location

**Table 32. POST Progress Code LED Example** 

In the following example, the BIOS sends a value of ACh to the diagnostic LED decoder. The LEDs are decoded as follows:

		Upper Nibble	AMBER LEDs		Lower Nibble GREEN LEDs			
LEDe	MSB							LSB
LEDs	LED #7	LED#6	LED #5	LED #4	LED#3	LED #2	LED#1	LED #0
	8h	4h	2h	1h	8h	4h	2h	1h
Status	ON	OFF	ON	OFF	ON	ON	OFF	OFF
Results	1	0	1	0	1	1	0	0
		Α	h		Ch			

 Upper nibble bits = 1010b = Ah; Lower nibble bits = 1100b = Ch; the two are concatenated as ACh.

Table 33. Diagnostic LED POST Code Decoder

Checkpoint			Diagn	ostic	LED [	Decoc	ler		Description
a	Diagnostic LED Decoder  1 = LED On, 0 = LED Off								
	_	er Nib	_			er Nit	hle		
	MSB		1				1	LSB	
	8h	4h	2h	1h	8h	4h	2h	1h	
LED#	# <b>7</b>	#6	#5		#3		#1	#0	
SEC Phase		""	110	111	"0	II	,, ,	110	
01h	0	0	0	0	0	0	0	1	First POST code after CPU reset
02h	0	0	0	0	0	0	1	0	Microcode load begin
03h	0	0	0	0	0	0	1	1	CRAM initialization begin
04h	0	0	0	0	0	1	0	0	Pei Cache When Disabled
05h	0	0	0	0	0	1	0	1	SEC Core At Power On Begin
06h	0	0	0	0	0	1	1	0	Early CPU initialization during Sec Phase
07h	0	0	0	0	0	1	1	1	Early SB initialization during Sec Phase
08h	0	0	0	0	1	0	0	0	Early NB initialization during Sec Phase
09h	0	0	0	0	1	0	0	1	End Of Sec Phase
0Eh	0	0	0	0	1	1	1	0	Microcode Not Found
0Fh	0	0	0	0	1	1	1	1	Microcode Not Loaded
PEI Phase	•								
10h	0	0	0	1	0	0	0	0	PEI Core
11h	0	0	0	1	0	0	0	1	CPU PEIM
15h	0	0	0	1	0	1	0	1	NB PEIM
19h	0	0	0	1	1	0	0	1	SB PEIM
MRC Proce	ss C	odes	s – M	RC F	rog	ress	Coc	le Sec	quence is executed - See <u>Table 32</u>
PEI Phase	conti	nue	k						
31h	0	0	1	1	0	0	0	1	Memory Installed
32h	0	0	1	1	0	0	1	0	CPU PEIM (CPU Init)
33h	0	0	1	1	0	0	1	1	CPU PEIM (Cache Init)
34h	0	0	1	1	0	1	0	0	CPU PEIM (BSP Select)
35h	0	0	1	1	0	1	0	1	CPU PEIM (AP Init)
36h	0	0	1	1	0	1	1	0	CPU PEIM (CPU SMM Init)
4Fh	0	1	0	0	1	1	1	1	Dxe IPL started
<b>DXE Phase</b>									
60h	0	1	1	0	0	0	0	0	DXE Core started
61h	0	1	1	0	0	0	0	1	DXE NVRAM Init
62h	0	1	1	0	0	0	1	0	SB RUN Init
63h	0	1	1	0	0	0	1	1	Dxe CPU Init
68h	0	1	1	0	1	0	0	0	DXE PCI Host Bridge Init
69h	0	1	1	0	1	0	0	1	DXE NB Init
6Ah	0	1	1	0	1	0	1	0	DXE NB SMM Init
70h	0	1	1	1	0	0	0	0	DXE SB Init
71h	0	1	1	1	0	0	0	1	DXE SB SMM Init
72h	0	1	1	1	0	0	1	0	DXE SB devices Init
78h	0	1	1	1	1	0	0	0	DXE ACPI Init
79h	0	1	1	1	1	0	0	1	DXE CSM Init
90h	1	0	0	1	0	0	0	0	DXE BDS Started
91h	1	0	0	1	0	0	0	1	DXE BDS connect drivers
92h	1	0	0	1	0	0	1	0	DXE PCI Bus begin
93h	1	0	0	1	0	0	1	1	DXE PCI Bus HPC Init
94h	1	0	0	1	0	1	0	0	DXE PCI Bus enumeration
95h	1	0	0	1	0	1	0	1	DXE PCI Bus resource requested
96h	1	0	0	1	0	1	1	0	DXE PCI Bus assign resource
97h	1	0	0	1	0	1	1	1	DXE CON_OUT connect

Checkpoint	Diagnostic LED Decoder					Decod	der		Description
	1 = 1			) = LED Off					
		er Nib				er Nit	nhle		
	MSB				LOVV	I IVIL		LSB	
	8h	4h	2h	1h	8h	4h	2h	1h	
LED#	#7	#6	#5	#4	#3	#2	#1	#0	
98h	1	0	0	1	#3 1	0	0	0	DXE CON_IN connect
99h	1	0	0	1	1	0	0	1	DXE SIO Init
9911 9Ah	1	0	0	1	1	0	1	0	DXE USB start
9Bh	1	0	0	1	1	0	1	1	DXE USB reset
9Ch	1	0	0	1	1	1	0	0	DXE USB detect
9Dh	1	0	0	1	1	1	0	1	DXE USB enable
A1h	1	0	1	0	0	0	0	1	DXE IDE begin
A2h	1	0	1	0	0	0	1	0	DXE IDE begin
A3h	1	0	1	0	0	0	1	1	DXE IDE detect
A4h	1	0	1	0	0	1	0	0	DXE IDE detect  DXE IDE enable
A5h	1	0	1	0	0	1	0	1	DXE SCSI begin
A6h	1	0	1	0	0	1	1	0	DXE SCSI reset
A7h	1	0	1	0	0	1	1	1	DXE SCSI detect
A8h	1	0	1	0	1	0	0	0	DXE SCSI detect
A9h	1	0	1	0	1	0	0	1	DXE verifying SETUP password
ABh	1	0	1	0	1	0	1	1	DXE SETUP start
ACh	1	0	1	0	1	1	0	0	DXE SETUP input wait
ADh	1	0	1	0	1	1	0	1	DXE Ready to Boot
AEh	1	0	1	0	1	1	1	0	DXE Legacy Boot
AFh	1	0	1	0	1	1	1	1	DXE Exit Boot Services
B0h	1	0	1	1	0	0	0	0	RT Set Virtual Address Map Begin
B1h	1	0	1	1	0	0	0	1	RT Set Virtual Address Map Begin
B2h	1	0	1	1	0	0	1	0	DXE Legacy Option ROM init
B3h	1	0	1	1	0	0	1	1	DXE Reset system
B4h	1	0	1	1	0	1	0	0	DXE USB Hot plug
B5h	1	0	1	1	0	1	0	1	DXE PCI BUS Hot plug
B6h	1	0	1	1	0	1	1	0	DXE NVRAM cleanup
B7h	1	0	1	1	0	1	1	1	DXE Configuration Reset
00h	0	0	0	0	0	0	0	0	INT19
S3 Resume		U	U	U	U	Į U	U	U	JIN TO
E0h	1	1	0	1	0	0	0	0	S3 Resume PEIM (S3 started)
E1h	1	1	0	1	0	0	0	1	S3 Resume PEIM (S3 stated)
E2h	1	1	0	1	0	0	1	0	S3 Resume PEIM (S3 Video Repost)
E3h	1	1	0	1	0	0	1	1	S3 Resume PEIM (S3 OS wake)
BIOS Recov		1	U		U	IO			JOO ROSume F Lim (OO OO ware)
F0h	1	1	1	1	0	0	0	0	PEIM which detected forced Recovery condition
F1h	1	1	1	1	0	0	0	1	PEIM which detected lorded Necovery condition
F2h	1	1	1	1	0	0	1	0	Recovery PEIM (Recovery started)
F3h	1	1	1	1	0	0	1	1	Recovery PEIM (Capsule found)
F4h	1	1	1	1	0	1	0	0	Recovery PEIM (Capsule loaded)
711	_	-	-	<u> </u>	0		9	9	1000 vory 1 Envi (Oapsule loaded)
L									

BFh

### **POST Memory Initialization MRC Diagnostic Codes**

There are two types of POST Diagnostic Codes displayed by the MRC during memory initialization; Progress Codes and Fatal Error Codes.

The MRC Progress Codes are displays to the Diagnostic LEDs that show the execution point in the MRC operational path at each step.

Diagnostic LED Decoder 1 = LED On, 0 = LED Off Checkpoint Upper Nibble Lower Nibble Description MSB LSB 8h 4h 2h 1h | 8h 2h 4h 1h LED #6 #4 #3 #0 **MRC Progress Codes** B0h Detect DIMM population B1h 0 0 Set DDR3 frequency 1 B2h 0 1 0 0 Gather remaining SPD data B3h 0 Program registers on the memory controller level 1 B4h 0 0 Evaluate RAS modes and save rank information B5h 0 0 Program registers on the channel level 0 Perform the JEDEC defined initialization sequence B6h 0 0 B7h 1 0 Train DDR3 ranks B8h 1 Initialize CLTT/OLTT 1 B9h 0 1 0 0 Hardware memory test and init BAh 1 0 Execute software memory init BBh 1 Program memory map and interleaving Program RAS configuration BCh

**Table 34. MRC Progress Codes** 

Memory Initialization at the beginning of POST includes multiple functions, including discovery, channel training, validation that the DIMM population is acceptable and functional, initialization of the IMC and other hardware settings, and initialization of applicable RAS configurations.

MRC is done

When a major memory initialization error occurs and prevents the system from booting with data integrity, a beep code is generated, the MRC will display a fatal error code on the diagnostic LEDs, and a system halt command is executed. Fatal MRC error halts do NOT change the state of the System Status LED, and they do NOT get logged as SEL events. The following table lists all MRC fatal errors that are displayed to the Diagnostic LEDs.

### **Table 35. MRC Fatal Error Codes**

			Diag	nostic I	LED De	ecoder			
			1 = L	.ED On,	, O = L(	D Off			
Checkpoint		Upper	Nibble	9		Lowe	Nibble	9	Donatation
	MSB							LSB	Description
	8h	4h	2h	1h	8h	4h	2h	1h	
LED	#7	#6	#5	#4	#3	#2	#1	#0	
MRC Fatal E	rror C	Codes	•						
E8h	1	1	1	0	1	0	0	0	No usable memory error  01h = No memory was detected from SPD read, or invalid config that causes no operable memory.  02h = Memory DIMMs on all channels of all sockets are disabled due to hardware memtest error.  3h = No memory installed. All channels are disabled.
E9h	1	1	1	0	1	0	0	1	Memory is locked by Intel Trusted Execution Technology and is inaccessible
EAh	1	1	1	0	1	0	1	0	DDR3 channel training error 01h = Error on read DQ/DQS (Data/Data Strobe) init 02h = Error on Receive Enable 3h = Error on Write Leveling 04h = Error on write DQ/DQS (Data/Data Strobe
EBh	1	1	1	0	1	0	1	1	Memory test failure  01h = Software memtest failure.  02h = Hardware memtest failed.  03h = Hardware Memtest failure in Lockstep Channel mode requiring a channel to be disabled. This is a fatal error which requires a reset and calling MRC with a different RAS mode to retry.
EDh	1	1	1	0	1	1	0	1	DIMM configuration population error 01h = Different DIMM types (UDIMM, RDIMM, LRDIMM) are detected installed in the system. 02h = Violation of DIMM population rules. 03h = The 3rd DIMM slot cannot be populated when QR DIMMs are installed. 04h = UDIMMs are not supported in the 3rd DIMM slot. 05h = Unsupported DIMM Voltage.
EFh	1	1	1	0	1	1	1	1	Indicates a CLTT table structure error

### Appendix C: POST Code Errors

Most error conditions encountered during POST are reported using **POST Error Codes**. These codes represent specific failures, warnings, or are informational. POST Error Codes may be displayed in the Error Manager display screen, and are always logged to the System Event Log (SEL). Logged events are available to System Management applications, including Remote and Out of Band (OOB) management.

There are exception cases in early initialization where system resources are not adequately initialized for handling POST Error Code reporting. These cases are primarily Fatal Error conditions resulting from initialization of processors and memory, and they are handled by a Diagnostic LED display with a system halt.

The following table lists the supported POST Error Codes. Each error code is assigned an error type which determines the action the BIOS will take when the error is encountered. Error types include Minor, Major, and Fatal. The BIOS action for each is defined as follows:

**Minor:** The error message is displayed on the screen or on the Error Manager screen, and an error is logged to the SEL. The system continues booting in a degraded state. The user may want to replace the erroneous unit. The POST Error Pause option setting in the BIOS setup does not have any effect on this error.

**Major:** The error message is displayed on the Error Manager screen, and an error is logged to the SEL. The POST Error **Pause** option setting in the BIOS setup determines whether the system pauses to the Error Manager for this type of error so the user can take immediate corrective action or the system continues booting.

Note that for 0048 "Password check failed", the system halts, and then after the next reset/reboot will displays the error code on the Error Manager screen.

**Fatal:** The system halts during post at a blank screen with the text "Unrecoverable fatal error found. System will not boot until the error is resolved" and "Press <F2> to enter setup" The POST Error Pause option setting in the BIOS setup does not have any effect with this class of error.

When the operator presses the **F2** key on the keyboard, the error message is displayed on the Error Manager screen, and an error is logged to the SEL with the error code. The system cannot boot unless the error is resolved. The user needs to replace the faulty part and restart the system.

**Note**: The POST error codes in the following table are common to all current generation Intel<sup>®</sup> server platforms. Features present on a given server board/system will determine which of the listed error codes are supported.

Table 36. POST Error Messages and Handling

Error Code	Error Message	Response			
0012	System RTC date/time not set Major				
0048	Password check failed	Major			
0140	PCI component encountered a PERR error	Major			
0141	PCI resource conflict	Major			
0146	PCI out of resources error	Major			

Error Code	Error Message	Response
0191	Processor core/thread count mismatch detected	Fatal
0192	Processor cache size mismatch detected	Fatal
0194	Processor family mismatch detected	Fatal
0195	Processor Intel <sup>®</sup> QPI link frequencies unable to synchronize	Fatal
0196	Processor model mismatch detected	Fatal
0190	Processor frequencies unable to synchronize	Fatal
5220	BIOS Settings reset to default settings	Major
5221	Passwords cleared by jumper	Major
5224	Password clear jumper is Set	Major
8130	Processor 01 disabled	Major
8131	Processor 02 disabled	Major
8132	Processor 03 disabled	Major
8133	Processor 04 disabled	Major
8160	Processor 01 unable to apply microcode update	Major
8161	Processor 02 unable to apply microcode update	Major
8162	Processor 03 unable to apply microcode update	Major
8163	Processor 04 unable to apply microcode update	Major
8170	Processor 01 failed Self Test (BIST)	Major
8171	Processor 02 failed Self Test (BIST)	Major
8172	Processor 03 failed Self Test (BIST)	Major
8173	Processor 04 failed Self Test (BIST)	Major
8180	Processor 01 microcode update not found	Minor
8181	Processor 02 microcode update not found	Minor
8182	Processor 03 microcode update not found	Minor
8183	Processor 04 microcode update not found	Minor
8190	Watchdog timer failed on last boot	Major
8198	OS boot watchdog timer failure	Major
8300	Baseboard management controller failed self-test	Major
8305	Hot Swap Controller failure	Major
83A0	Management Engine (ME) failed Selftest	Major
83A1	Management Engine (ME) Failed to respond.	Major
84F2	Baseboard management controller failed to respond	Major
84F3	Baseboard management controller in update mode	Major
84F4	Sensor data record empty	Major
84FF	System event log full	Minor
8500	Memory component could not be configured in the selected RAS mode	Major
8501	DIMM Population Error	Major
8520	DIMM_A1 failed test/initialization	Major
8521	DIMM_A2 failed test/initialization	Major
8522	DIMM_A3 failed test/initialization	Major
8523	DIMM_B1 failed test/initialization	Major
8524	DIMM_B2 failed test/initialization	Major
8525	DIMM_B3 failed test/initialization	Major
8526	DIMM_C1 failed test/initialization	Major
8527	DIMM_C2 failed test/initialization	Major
8528	DIMM_C3 failed test/initialization	Major
8529	DIMM_D1 failed test/initialization	Major
852A	DIMM_D2 failed test/initialization	Major
852B	DIMM_D3 failed test/initialization	Major
852C	DIMM_E1 failed test/initialization	Major
852D	DIMM_E2 failed test/initialization	Major
852E	DIMM_E3 failed test/initialization	Major
852F	DIMM_F1 failed test/initialization	Major
8530	DIMM_F2 failed test/initialization	Major
8531	DIMM_F3 failed test/initialization	Major
8532	DIMM_G1 failed test/initialization	Major
8533	DIMM_G2 failed test/initialization	Major
8534	DIMM_G3 failed test/initialization	Major

Error Code	Error Message	Response
8535	DIMM_H1 failed test/initialization	Major
8536	DIMM_H2 failed test/initialization	Major
8537	DIMM_H3 failed test/initialization	Major
8538	DIMM_I1 failed test/initialization	Major
8539	DIMM_I2 failed test/initialization	Major
853A	DIMM_I3 failed test/initialization	Major
853B	DIMM_J1 failed test/initialization	Major
853C	DIMM_J2 failed test/initialization	Major
853D	DIMM_J3 failed test/initialization	Major
853E	DIMM_K1 failed test/initialization	Major
853F	DIMM_K2 failed test/initialization	Major
(Go to		
85C0)		
8540	DIMM_A1 disabled	Major
8541	DIMM_A2 disabled	Major
8542	DIMM_A3 disabled	Major
8543	DIMM_B1 disabled	Major
8544	DIMM_B2 disabled	Major
8545 8546	DIMM_B3 disabled DIMM_C1 disabled	Major
		Major
8547 8548	DIMM_C2 disabled	Major
8548	DIMM_C3 disabled DIMM_D1 disabled	Major
854A	DIMM_D2 disabled	Major Major
854B	DIMM_D3 disabled	Major
854C	DIMM_E1 disabled	Major
854D	DIMM_E2 disabled	Major
854E	DIMM_E3 disabled	Major
854F	DIMM_F1 disabled	Major
8550	DIMM_F2 disabled	Major
8551	DIMM_F3 disabled	Major
8552	DIMM_G1 disabled	Major
8553	DIMM_G2 disabled	Major
8554	DIMM_G3 disabled	Major
8555	DIMM_H1 disabled	Major
8556	DIMM_H2 disabled	Major
8557	DIMM_H3 disabled	Major
8558	DIMM_I1 disabled	Major
8559	DIMM I2 disabled	Major
855A	DIMM_I3 disabled	Major
855B	DIMM_J1 disabled	Major
855C	DIMM_J2 disabled	Major
855D	DIMM_J3 disabled	Major
855E	DIMM_K1 disabled	Major
855F	DIMM_K2 disabled	Major
(Go to		
85D0)		
8560	DIMM_A1 encountered a Serial Presence Detection (SPD) failure	Major
8561	DIMM_A2 encountered a Serial Presence Detection (SPD) failure	Major
8562	DIMM_A3 encountered a Serial Presence Detection (SPD) failure	Major
8563	DIMM_B1 encountered a Serial Presence Detection (SPD) failure	Major
8564	DIMM_B2 encountered a Serial Presence Detection (SPD) failure	Major
8565	DIMM_B3 encountered a Serial Presence Detection (SPD) failure	Major
8566	DIMM_C1 encountered a Serial Presence Detection (SPD) failure	Major
8567	DIMM_C2 encountered a Serial Presence Detection (SPD) failure	Major
8568	DIMM_C3 encountered a Serial Presence Detection (SPD) failure	Major
8569	DIMM_D1 encountered a Serial Presence Detection (SPD) failure	Major
856A	DIMM_D2 encountered a Serial Presence Detection (SPD) failure	Major

Error Code	Error Message	Response
856B	DIMM_D3 encountered a Serial Presence Detection (SPD) failure	Major
856C	DIMM_E1 encountered a Serial Presence Detection (SPD) failure	Major
856D	DIMM_E2 encountered a Serial Presence Detection (SPD) failure	Major
856E	DIMM_E3 encountered a Serial Presence Detection (SPD) failure	Major
856F	DIMM_F1 encountered a Serial Presence Detection (SPD) failure	Major
8570	DIMM_F2 encountered a Serial Presence Detection (SPD) failure	Major
8571	DIMM_F3 encountered a Serial Presence Detection (SPD) failure	Major
8572	DIMM_G1 encountered a Serial Presence Detection (SPD) failure	Major
8573	DIMM_G2 encountered a Serial Presence Detection (SPD) failure	Major
8574	DIMM_G3 encountered a Serial Presence Detection (SPD) failure	Major
8575	DIMM_H1 encountered a Serial Presence Detection (SPD) failure	Major
8576	DIMM_H2 encountered a Serial Presence Detection (SPD) failure	Major
8577	DIMM H3 encountered a Serial Presence Detection (SPD) failure	Major
8578	DIMM_I1 encountered a Serial Presence Detection (SPD) failure	Major
8579	DIMM_I2 encountered a Serial Presence Detection (SPD) failure	Major
857A	DIMM_I3 encountered a Serial Presence Detection (SPD) failure	Major
857B	DIMM_J1 encountered a Serial Presence Detection (SPD) failure	Major
857C	DIMM_J2 encountered a Serial Presence Detection (SPD) failure	Major
857D	DIMM_J3 encountered a Serial Presence Detection (SPD) failure	Major
857E	DIMM_K1 encountered a Serial Presence Detection (SPD) failure	Major
857F	DIMM_K2 encountered a Serial Presence Detection (SPD) failure	Major
(Go to	Divini_12 on obtainer of a contain resolute Detection (or b) failure	Major
85E0)		
85C0	DIMM K3 failed test/initialization	Major
85C1	DIMM L1 failed test/initialization	Major
85C2	DIMM_L2 failed test/initialization	Major
85C3	DIMM_L3 failed test/initialization	Major
85C4	DIMM_M1 failed test/initialization	Major
85C5	DIMM_M2 failed test/initialization	Major
85C6	DIMM_M3 failed test/initialization	Major
85C7	DIMM_N1 failed test/initialization	Major
85C8	DIMM_N2 failed test/initialization	Major
85C9	DIMM_N3 failed test/initialization	Major
85CA	DIMM_O1 failed test/initialization	Major
85CB	DIMM_O2 failed test/initialization	Major
85CC	DIMM_O3 failed test/initialization	Major
85CD	DIMM_P1 failed test/initialization	Major
85CE	DIMM_P2 failed test/initialization	Major
85CF	DIMM_P3 failed test/initialization	Major
85D0	DIMM_K3 disabled	Major
85D1	DIMM_L1 disabled	Major
85D2	DIMM_L2 disabled	Major
85D3	DIMM_L3 disabled	Major
85D4	DIMM_M1 disabled	Major
85D5	DIMM_M2 disabled	Major
85D6	DIMM_M3 disabled	Major
85D7	DIMM_N1 disabled	Major
85D8	DIMM_N2 disabled	Major
85D9	DIMM_N3 disabled	Major
85DA	DIMM_O1 disabled	Major
85DB	DIMM_O2 disabled	Major
85DC	DIMM_O3 disabled	Major
85DD	DIMM_P1 disabled	Major
85DE	DIMM_P2 disabled	Major
85DF	DIMM_P3 disabled	Major
85E0	DIMM_K3 encountered a Serial Presence Detection (SPD) failure	Major
85E1 85E2	DIMM_L1 encountered a Serial Presence Detection (SPD) failure  DIMM_L2 encountered a Serial Presence Detection (SPD) failure	Major
USEZ	DIMINI_LZ GILOUTIGIEU A SCHAL FIESCHOE DELECTION (SFD) IAIIUIE	Major

Error Code	Error Message	Response				
85E3	DIMM_L3 encountered a Serial Presence Detection (SPD) failure	Major				
85E4	DIMM_M1 encountered a Serial Presence Detection (SPD) failure	Major				
85E5	DIMM_M2 encountered a Serial Presence Detection (SPD) failure	Major				
85E6	DIMM_M3 encountered a Serial Presence Detection (SPD) failure	Major				
85E7	DIMM_N1 encountered a Serial Presence Detection (SPD) failure	Major				
85E8	DIMM_N2 encountered a Serial Presence Detection (SPD) failure	Major				
85E9	DIMM_N3 encountered a Serial Presence Detection (SPD) failure	Major				
85EA	DIMM_O1 encountered a Serial Presence Detection (SPD) failure	Major				
85EB	DIMM_O2 encountered a Serial Presence Detection (SPD) failure	Major				
85EC	DIMM_O3 encountered a Serial Presence Detection (SPD) failure	Major				
85ED	DIMM_P1 encountered a Serial Presence Detection (SPD) failure	Major				
85EE	DIMM_P2 encountered a Serial Presence Detection (SPD) failure	Major				
85EF	DIMM_P3 encountered a Serial Presence Detection (SPD) failure	Major				
8604	POST Reclaim of non-critical NVRAM variables	Minor				
8605	BIOS Settings are corrupted	Major				
8606	NVRAM variable space was corrupted and has been reinitialized	Major				
92A3	Serial port component was not detected	Major				
92A9	Serial port component encountered a resource conflict error	Major				
A000	TPM device not detected.	Minor				
A001	TPM device missing or not responding.	Minor				
A002	TPM device failure.	Minor				
A003	TPM device failed self test.	Minor				
A100	BIOS ACM Error Major					
A421	PCI component encountered a SERR error Fatal					
A5A0	PCI Express* component encountered a PERR error Minor					
A5A1	PCI Express* component encountered an SERR error	Fatal				
A6A0	DXE Boot Service driver: Not enough memory available to shadow a Legacy Option ROM  Minor					

### **POST Error Beep Codes**

The following table lists the POST error beep codes. Prior to system video initialization, the BIOS uses these beep codes to inform users on error conditions. The beep code is followed by a user-visible code on the POST Progress LEDs.

**Table 37. POST Error Beep Codes** 

Beeps	Error Message	POST Progress Code	Description
1	USB device action	NA	Short beep sounded whenever a USB device is discovered in POST, or inserted or removed during runtime
1 long	Intel <sup>®</sup> TXT security violation	0xAE, 0xAF	System halted because Intel <sup>®</sup> Trusted Execution Technology detected a potential violation of system security.
3	Memory error	See Tables 28 and 29	System halted because a fatal error related to the memory was detected.
2	BIOS Recovery started	NA	Recovery boot has been initiated
4	BIOS Recovery failure	NA	BIOS recovery has failed. This typically happens so quickly after recovery us initiated that it sounds like a 2-4 beep code.

The Integrated BMC may generate beep codes upon detection of failure conditions. Beep codes are sounded each time the problem is discovered, such as on each power-up attempt, but are not sounded continuously. Codes that are common across all Intel<sup>®</sup> server boards and systems

that use same generation chipset are listed in the following table. Each digit in the code is represented by a sequence of beeps whose count is equal to the digit.

**Table 38. Integrated BMC Beep Codes** 

Code	Reason for Beep	Associated Sensors
1-5-2-1	No CPUs installed or first CPU socket is empty.	CPU1 socket is empty, or sockets are populated incorrectly CPU1 must be populated before CPU2.
1-5-2-4	MSID Mismatch	MSID mismatch occurs if a processor is installed into a system board that has incompatible power capabilities.
1-5-4-2	Power fault	DC power unexpectedly lost (power good dropout)  – Power unit sensors report power unit failure offset
1-5-4-4	Power control fault (power good assertion timeout).	Power good assertion timeout – Power unit sensors report soft power control failure offset
1-5-1-2	VR Watchdog Timer sensor assertion	VR controller DC power on sequence was not completed in time.
1-5-1-4	Power Supply Status	The system does not power on or unexpectedly powers off and a Power Supply Unit (PSU) is present that is an incompatible model with one or more other PSUs in the system.

## Glossary

Word/Acronym	Definition
ACA	Australian Communication Authority
ANSI	American National Standards Institute
BMC	Baseboard Management Controller
BIOS	Basic Input/Output System
CMOS	Complementary Metal-oxide-semiconductor
D2D	DC-to-DC
EMP	Emergency Management Port
FP	Front Panel
FRB	Fault Resilient Boot
FRU	Field Replaceable Unit
I <sup>2</sup> C	Inter-integrated Circuit bus
LCD	Liquid Crystal Display
LPC	Low-pin Count
LSB	Least Significant Bit
MSB	Most Significant Bit
MTBF	Mean Time Between Failure
MTTR	Mean Time to Repair
NIC	Network Interface Card
NMI	Non-maskable Interrupt
OTP	Over-temperature Protection
OVP	Over-voltage Protection
PCI	Peripheral Component Interconnect
PCB	Printed Circuit Board
PCIe*	Peripheral Component Interconnect Express*
PCI-X	Peripheral Component Interconnect Extended
PFC	Power Factor Correction
POST	Power-on Self Test
PSU	Power Supply Unit
RAM	Random Access Memory
RI	Ring Indicate
SCA	Single Connector Attachment
SDR	Sensor Data Record
SE	Single-Ended
THD	Total Harmonic Distortion
UART	Universal Asynchronous Receiver Transmitter
USB	Universal Serial Bus
VCCI	Voluntary Control Council for Interference
VSB	Voltage Standby

### Reference Documents

See the following documents for additional information:

- 1. Intel® Server Board S2400SC Technical Product Specification
- 2. Intel® Server Board S2400SC Product Family Spares/Parts List and Configuration Guide
- 3. Intel® Server System R2000SC Service Guide
- 4. Intel® Server System R2000SC Quick Installation Guide
- 5. Intel® S2400SC Product Family Power Budget and Thermal Configuration Tool
- 6. BIOS for EPSD Platforms Based on Intel® Xeon Processor E5-4600/2600/2400/1600 Product Families External Product Specification
- 7. EPSD Platforms Based On Intel® Xeon® Processor E5 4600/2600/2400/1600 Product Families BMC Core Firmware External Product Specification
- 8. SmaRT & CLST Architecture on "Romley" Systems and Power Supplies Specification (Doc Reference # 461024)
- 9. Intel® RAID Expander Card RES2SV240 Hardware Users Guide
- 10. SmaRT & CLST Architecture on "Romley" Systems and Power Supplies Specification (Doc Reference # 461024)
- 11. Intel® Remote Management Module 4 Technical Product Specification
- 12. Intel® Remote Management Module 4 and Integrated BMC Web Console Users Guide
- 13. Intel® Server Board S2400SC and Intel® Server System R2000SC Monthly Specification Update